Service Manual

Telephone Equipment

KX-TC1709LBB

900MHz Digital Cordless Phone

Black Version

(for Brazil)



(Handset)

(Base Unit)

SPECIFICATIONS

	Base Unit	Handset
Power Source: Receiving Frequency: Receiving Method: Transmitting Frequency: Oscillation Method: Tolerance of OSC Frequency: Modulation Method: Spread spectrum Method: Chip rate	AC Adaptor (PQLV2LBZ) 22 channels within 902.00~928.00 MHz Double super heterodyne 22 channels within 902.00~928.00 MHz PLL synthesizer 4.096 MHz TDD-FSK	Rechargeable Ni-Cd battery 22 channels within 902.00~928.00 MHz Double super heterodyne 22 channels within 902.00~928.00 MHz PLL synthesizer 4.096 MHz TDD-FSK
ID Code: Dial Mode: Redial: Speed Dialer: Power Consumption: Dimension (H×W×D): Weight	28-bit 3 11/ ₃₂ " × 4 ⁷ / ₃₂ " × 8 1/ ₄ " (85 × 107 × 210mm) 0.56 lbs. (256 g)	28-bit Tone (DTMF)/Pulse Up to 32 digits 14 days at Standby, 6 hours at Talk 1 5/s" × 2 5/32" × 9 7/16" (41 × 55 × 240 mm) 0.49 lbs. (222g) with battery

Design and specifications are subject to change without notice.

⚠ WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

When you mention the serial number, write down all 11 digits. The serial number may be found on the label affixed to the bottom of the unit.

FOR SERVICE TECHNICIANS

ICs and LSIs are vulnerable to static electricity.

When replacing, the following precautions will help prevent recurring malfunctions.

- 1. Cover the plastic parts boxes with aluminum foil.
- 2. Ground the soldering irons.
- 3. Use a conductive mat on the work table.
- 4. Do not grasp IC or LSI pins with bare fingers.

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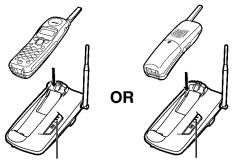
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1 STANDARD BATTERY LIFE

Battery Charge

Place the handset on the base unit and charge for about 15 hours before initial use.

• The IN USE/CHARGE/HOLD indicator lights.



IN USE/CHARGE/HOLD Indicator

Battery strength

You can check the battery strength on the display while the handset is on the base unit, while it is in use (making/answering a call etc.), or after viewing the Caller List, or directory items, programming, etc.

The battery strength will remain on the display for a few seconds after using the handset, then the display will return to the standby mode.

The battery strength is as shown in the chart below.

Display prompt	Battery strength	
{ ***]	Fully charged	
{ ■■]	Medium	
[■]	Low	
ູ້ [Needs to be recharged.	

Recharge

Recharge the battery when:

- "Recharge" is displayed,
- " []" flashes on the handset display, or
- The handset beeps intermittently while it is in use.



• If you DO NOT recharge the handset battery for more than 15 minutes, the display will keep indicating "Reharge" and/or "{ ■1" will continue to flash.

Battery information

After your Panasonic battery is fully charged;

Operation	Approx, battery life
While in use (TALK)	Up to about 6 hours
While not in use (Standby)	Up to about 14 days

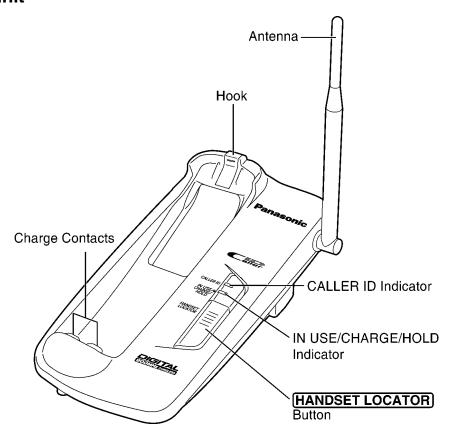
- The battery operating time may be shortened depending on usage conditions, such as viewing the Caller ID Caller List or directory list and ambient temperature.
- Clean the handset and the base unit charge contacts with a soft, dry cloth. Clean if the unit is subject to grease, dust or high humidity. Otherwise the battery may not charge properly.
- If the battery is fully charged, you do not have to place the handset on the base unit until "Recharge battery" is displayed and/or " {]" flashes. This will maximize the battery life.
- The battery cannot be overcharged.

Standby mode (While the handset is off the base unit)

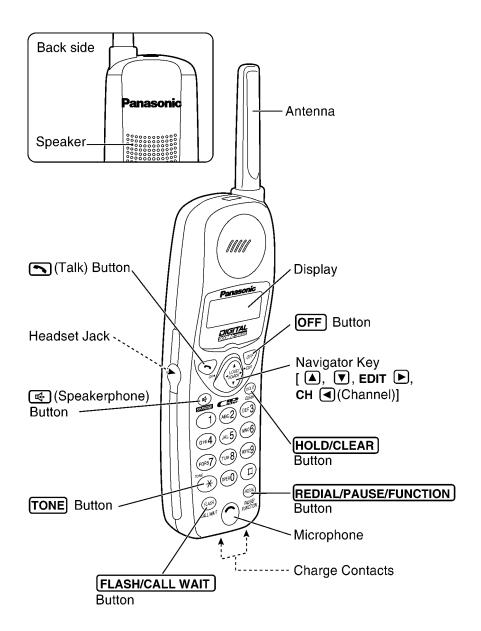
The handset goes into the standby mode after you finish using the handset (making/answering a call, viewing the Caller List or directory list etc.). The display is blank, but the handset can receive calls. The battery life is conserved in this mode.

2 LOCATION OF CONTROLS

2.1. Base unit



2.2. Handset

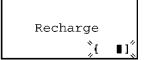


3 DISPLAY

The handset shows you instructions and information on the display. These display prompts are shown below.

No items stored

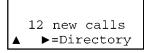
The Caller List is empty or there are no stored items in the directory.



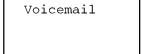
The battery needs to be charged. Place the handset on the base unit to charge the battery.



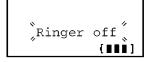
The display shows the number of new calls and the battery strength while the handset is on the base unit.



To search from the most recent call, press ▼. To search from the oldest call, press ▲. To go to the directory list, press EDIT ▶ (Directory key).



The display shows the voice mail message(s) is/are recorded.



When the ringer volume is set to OFF, "Ringer off" will flash for about 45 seconds before the unit returns to the standby mode.

10002223333

When a call is received, the display shows the caller's name and number after the first ring.

 During a conversation, the display shows the length of the call (ex. 1 hour, 6 minutes and 35 seconds). The battery strength is also displayed.

No link to base. Place on cradle and try again. The handset has lost communication with the base unit. Place the handset on the base unit and try again.

12223334444 ×3 This is a an information the Caller List. The display shows:

—the caller's number and

—the number of times called (ex. 3 times).

Ann 1234567890 This is a name from the directory. The stored name and phone number are displayed.

Directory full

When trying to store an item or Caller List information in the directory, the directory memory is full.

Save error

During a programming procedure, the handset has lost communication with the base unit. Move closer to the base unit.

Hold

00-00-08 [

An outside call has been put on hold by the handset. To release the hold, press or .

Please lift up and try again.

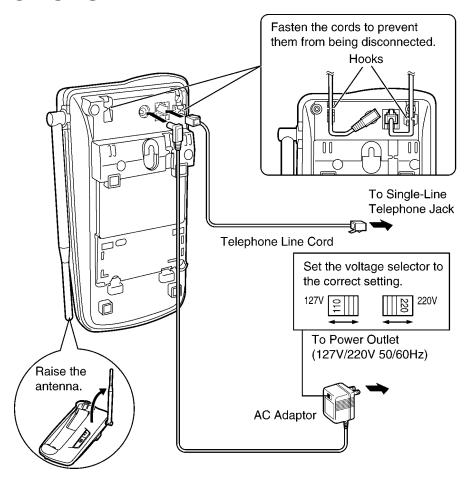
▼, ▲, CH ◀ or EDIT ▶ was pressed while the handset was on the base unit.

Lift the handset and press the button again.

Not available

 \blacktriangledown , \blacktriangle , CH \blacktriangleleft or EDIT \blacktriangleright was pressed while the base unit was not in the standby mode.

4 CONNECTIONS

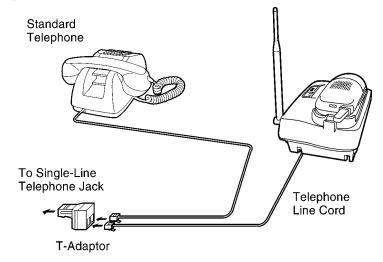


Note:

- · USE ONLY WITH Panasonic AC ADAPTOR PQLV2LBZ.
- · The AC adaptor must remain connected at all times. (It is normal for the adaptor to feel warm during use.)
- · If your unit is connected to a PBX which does not support Caller ID, you cannot access the service.

4.1. Adding Another Phone

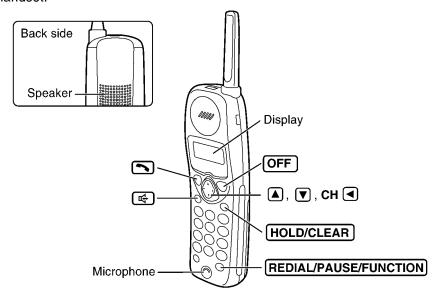
This unit will not function during a power failure. To connect a standard telephone on the same line, use the Panasonic T-adaptor.



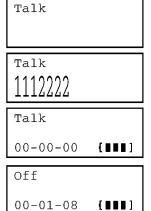
5 OPERATION

5.1. Making Calls

To have a hands-free conversation, connect an optional headset to the handset.



- 1 Press 🔼.
- **7** Dial a phone number.
 - The dialed number is displayed.
 - After a few seconds, the display will show the length of the call and the battery strength.
- To hang up, press **OFF** or place the handset on the base unit.



• If "No link to base Place on cradle and try again." is displayed and an alarm tone sounds in step 1, move closer to the base unit or place the handset on the base unit, and try again.

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To have a hands-free phone conversation (Using Digital Duplex Speakerphone)

SP-phone

Dial a phone number.

- •The dialed number is displayed.
- After a few seconds, the display will show the length of the call and the battery strength.

SP-phone 1112222 SP-phone

When the other party answers, talk into the microphone.

To hang up, press **OFF** or place the handset on the base unit.

• If "No link to base Place on cradle and try again." is displayed and an alarm tone sounds in step 1, move closer to the base unit or place the handset on the base unit, and try again.

Hands-free Digital Duplex Speakerphone

For best performance, please note the following:

- •Talk alternately with the caller in a quiet room.
- •If the other party has difficulty hearing you, press voto decrease the speaker volume.
- If the other party's voice from the speaker cuts in/out during a conversation, press 🔻 to decrease the speaker volume.
- •While talking using , you can switch to the hands-free phone conversation by pressing . To switch back to the receiver, press .

If noise interferes with the conversation

Press **CH** do select a clearer channel in the talk, speakerphone, intercom or remote operation mode, or move closer to the base unit.

To redial the last number dialed on the handset

Press or REDIAL/PAUSE/FUNCTION].

To dial after confirming the entered number

1 Dial a phone number.

• If you misdial, press

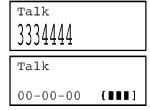
[HOLD/CLEAR]. One digit is erased from the right. Dial the correct phone number.

3334444

Press .

To have a hands-free phone conversation, press , and when the other party answers, talk into the microphone.

• After a few seconds, the display will show the length of the call and the battery strength.



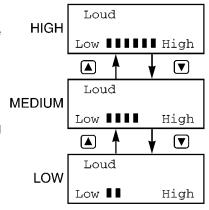
7 To hang up, press OFF or place the handset on the base unit.

To adjust the receiver volume (HIGH, MEDIUM or LOW) or speaker volume (6 levels) while talking

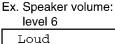
Press ▲ or ▼ while talking.

While using <a>

- Each time you press ▲ or ▼, the volume level will change from MEDIUM (preset) to HIGH or LOW.
- The display will return to the length of the call.
- When you replace the battery, the selected receiver volume setting will return to the factory set (MEDIUM). Reprogram if necessary.



While using 🚭



Loud

KX-TC1709LBB

To put a call on hold

Press HOLD/CLEAR.

- "Hold" is displayed.
- The IN USE/CHARGE/HOLD indicator on the base unit flashes.
- If you do not press any key more than 6 minutes, an alarm tone will sound.
- If you do not press any key more than 10 minutes after holding a call, a line will be disconnected.

Hold	
00-00-08	[

To release the hold

From the handset, press \bigcirc or \bigcirc .

• If another phone is connected on the same line, you can also release the hold by lifting its handset.

Backlit LCD display

The lighted handset display will stay on for a few seconds after pressing a handset button, lifting the handset off the base unit, hanging up a call, leaving the programming mode.

5.2. Answering Calls

When a call is received, the unit rings and the CALLER ID indicator on the base unit flashes quickly. If you subscribe to a Caller Display service, the calling party information will be displayed after the first ring. In order to view the Caller ID information, please wait until the second ring to answer a call.

5.2.1. With the Handset

If the handset off the base unit; Press .

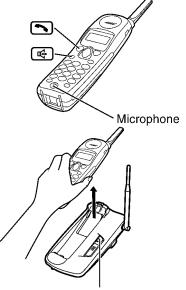
• You can also answer a call by pressing any dialing button **(0)** to **(9)**, **(★)** or **(□)** (—**Any Key Talk**).

OR

Press , and when the other party answers, talk into the microphone.

Auto Talk

If you set the Auto Talk feature to ON, you can answer a call by lifting the handset off the base unit without pressing \frown or \frown or



CALLER ID Indicator

When an optional headset is connected, make sure to use the headset to talk with the caller. If you want to have a normal cordless phone conversation, disconnect the headset.

5.3. FLASH Button

Pressing **FLASH/CALL WAIT** allows you to use special features of your host PBX such as transferring an extension call or accessing special telephone services (optional) such as call waiting.

Selecting the flash time

The flash time depends on your telephone exchange or host PBX. You can select the following flash times: "700, 600, 400, 300, 250, 110, 100 or 90 ms (milliseconds)". Your phone comes from the factory set to "700 ms".

Make sure the unit is in the standby mode.

Press [REDIAL/PAUSE/FUNCTION].

Press or A repeatedly until the arrow points to "Program".

Ringer volume
Program
Save directory

? Press EDIT ▶.

Press or A repeatedly until the arrow points to "Set flash time".

LCD contrast ▶Set flash time Set line mode

Press EDIT .

Flash time :700ms VA ▶=Save

Press or repeatedly until the desired time is displayed.

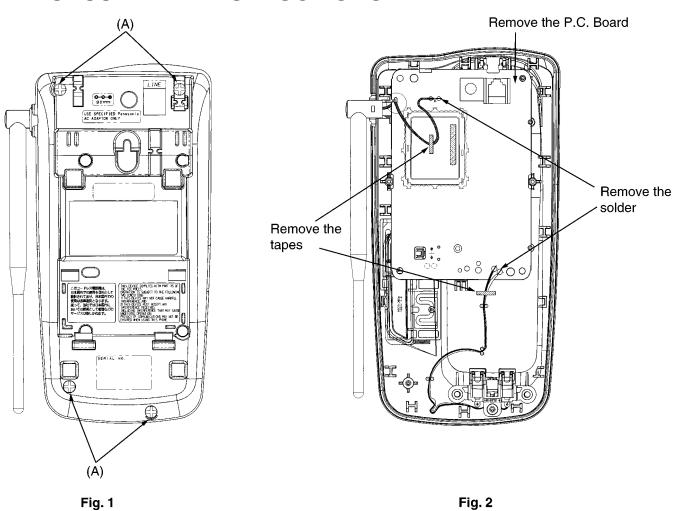
7 Press **EDIT ▶** (Save key).

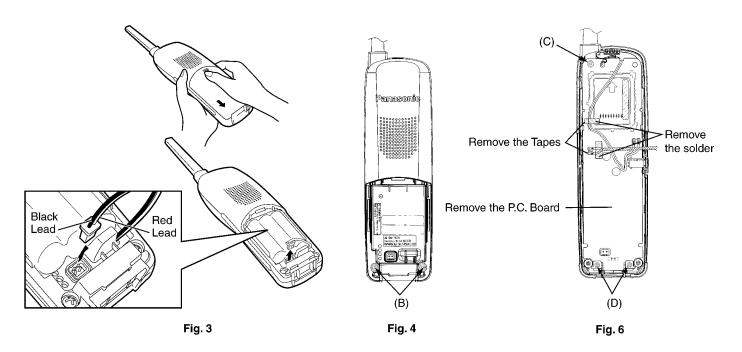
- A beep sounds.
 - To return to the standby mode, press OFF.

Flash time :110ms

- You can exit the programming mode any time by pressing **OFF**
- If you are connected via a PBX, a longer flash time may be necessary to use PBX functions (transferring a call etc.). Consult your PBX supplier for the correct setting.

DISASSEMBLY INSTRUCTIONS





Note: When opening the upper cabinet, be careful of the speaker lead wire.

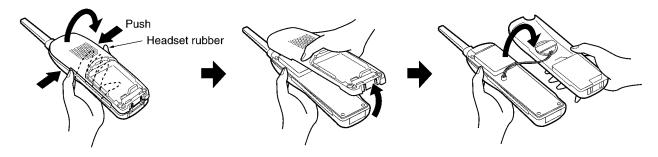
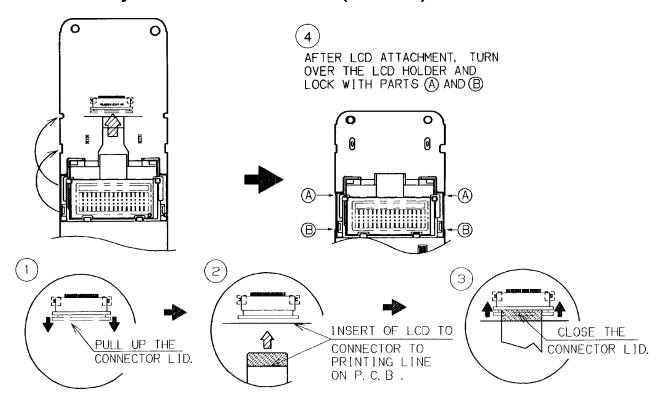


Fig. 5

Shown in Fig.	ig. To Remove Remove	
1	Lower Cabinet	Screws (2.6 X 12)(A) × 4
2	Main P.C. Board	Tapes and solder
		Main P.C. Board
3	Battery Cover	Battery Cover
4	Rear Cabinet	Screws (2.6 X 12)(B) x 2
5	Rear Cabinet	Rear Cabinet
6	Main P.C. Board	Screw (2.6 × 12)(C) × 1
		Screws (2.6 × 10)(D) × 2
		Lead wire
		Main P.C. Board

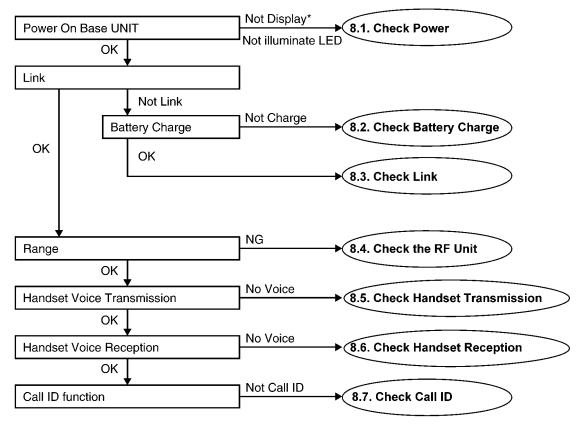
7 ASSEMBLY INSTRUCTIONS

7.1. Assembly the LCD to P.C. Board (Handset)



8 TROUBLESHOOTING GUIDE

MAIN



^{*}Depending on the Model.

Cross Reference:

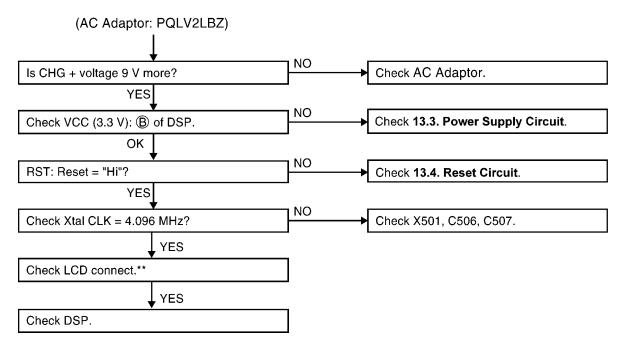
- 8.1. Check Power (P.22)
- 8.2. Check Battery Charge (P.23)
- 8.3. Check Link (P.23)
- 8.4. Check the RF Unit (P.24)
- 8.5. Check Handset Transmission (P.29)
- 8.6. Check Handset Reception (P.29)
- 8.7. Check Call ID (P.29)

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8.1. Check Power

BASE UNIT

Is the AC Adaptor inserted into AC outlet?* (*Check the AC Adaptor's specification.)



Cross Reference:

13.3. Power Supply Circuit (P.40)

13.4. Reset Circuit (P.41)

NOTE:

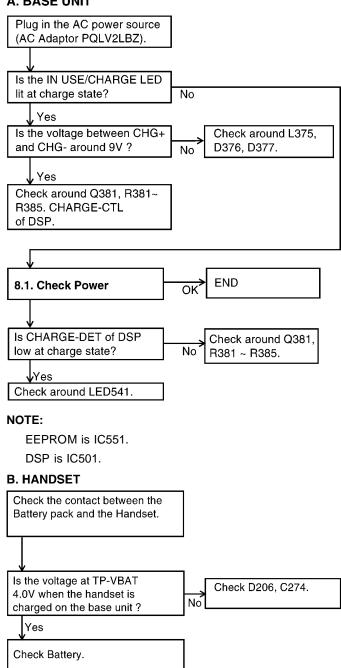
EEPROM is IC551.

DSP is IC501.

** Models with no LCD can skip.

8.2. Check Battery Charge

A. BASE UNIT

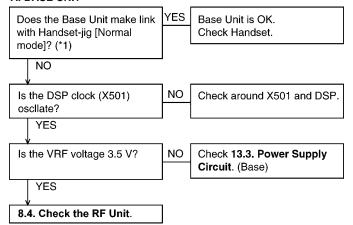


Cross Reference:

8.1. Check Power (P.22)

8.3. Check Link

A. BASE UNIT

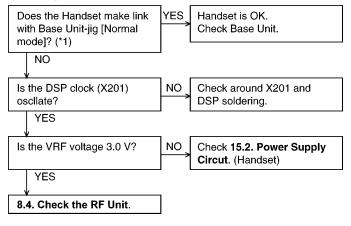


NOTE:

EEPROM is IC551.

DSP is IC501.

B. HANDSET



(*1) Refer to 8.4.1. Finding out the Defective Unit (P.24).

Cross Reference:

- 8.4. Check the RF Unit (P.24)
- 13.3. Power Supply Circuit (P.40)
- 15.2. Power Supply Circuit (P.48)

8.4. Check the RF Unit

8.4.1. Finding out the Defective Unit

Prepare HS JIG (Handset-jig) and BS JIG (Base Unit-jig) 2). Place the HS JIG on the cradle of the base unit for checking, then confirm that they are linked. Place the handset for checking on the cradle of the BS JIG, then confirm that they are linked. How to confirm the link is as follows; press the TALK button and confirm that the LEDs of the base unit is turned ON.

8.4.2. Check Items

8.4.2.1. Handset-jig (HS JIG) for Base Unit

The handset unit jig also uses two modes: TEST LOW mode and NORMAL POWER mode.

- (1) NORMAL POWER mode (Stand-By). In this mode the LCD will remain blank.
- (2) TEST LOW mode. Place the portable unit on the base unit while pushing FLASH and ⋈ key at the same time within 5 seconds after Power supply the portable unit. Refer to fixation CH table, figure 1 for the ⋈ key. This test simulates the handset is at very large distance from the base unit and the TX signal from handset to base is very small.

Procedure: First place handset jig on base under test to charge (exchange security code); press CLEAR and then TALK to operate. The LCD will show TALK. This means that the base unit sensitivity is OK.

* HS JIG becomes [NORMAL POWER] mode immediately after the power supply turning on.

NOTES:

- 1) If when setting the handset to TEST LOW mode, if handset beeps 3 times and the LCD shows "No link to base. Place on cradle and try again", press 2, 5, 8, 0 simultaneously and then disconnect battery. Re-install battery, place unit on cradle to get security codes and tries again.
- 2) Only KX-TC1703 with marks HS JIG/BS JIG can be used for troubleshooting. However, regular production set also can be used as a JIG.

Fixation CH	Figure 1	
CH	POWER	making key
1CH	"Lo"	"FLASH" + "1"
3CH	"Lo"	"FLASH" + "2"
5CH	"Lo"	"FLASH" + "3"
7CH	"Lo"	"FLASH" + "4"
9CH	"Lo"	"FLASH" + "5"
11CH	"Lo"	"FLASH" + "6"
13CH	"Lo"	"FLASH" + "7"
15CH	"Lo"	"FLASH" + "8"
17CH	"Lo"	"FLASH" + "9"
19CH	"Lo"	"FLASH" + " X "
21CH	"Lo"	"FLASH" + "0"

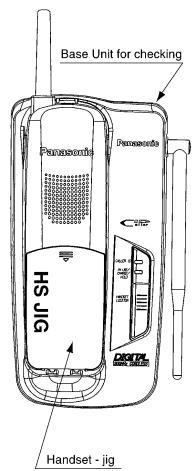


Fig. Using TC1703 Handset-jig.

* KX-TC1703 is used as the jig.

8.4.2.2. Base Unit - jig (BS JIG) for Handset

The base unit jig uses two modes: NORMAL POWER mode and TEST POWER mode.

- (1) NORMAL POWER mode. This test simulates the handset is at normal/close distance. The base unit is in NORMAL POWER mode right after the AC adapter has been inserted.
- (2) TEST LOW (POWER) mode. Place the portable unit on the base unit while pushing FLASH and

 key at the same time within 5 seconds after Power supply the portable unit. Refer to fixation CH table, figure 1 for the

 key. This test simulates the handset is at very large distance from the base unit and the TX signal from base to handset is very small.

Procedure: First, place handset under test to charge (exchange security code), then remove handset from base after you hear a beep. Press TALK button on handset and if it links with the base, then this handset sensitivity is OK.

* BS JIG becomes [NORMAL POWER] mode immediately after the power supply turning on.

NOTES:

- 1) If when setting the base to TEST LOW mode, if handset beeps 3 times, press 2, 5, 8, 0 simultaneously and then disconnect battery. Re-install battery, place unit on cradle to get security codes and tries again.
- 2) Only KX-TC1703 with marks BS JIG/HS JIG can be used for troubleshooting. However, regular production set also can be used as a JIG.

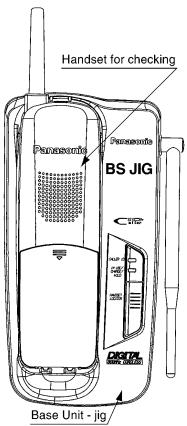
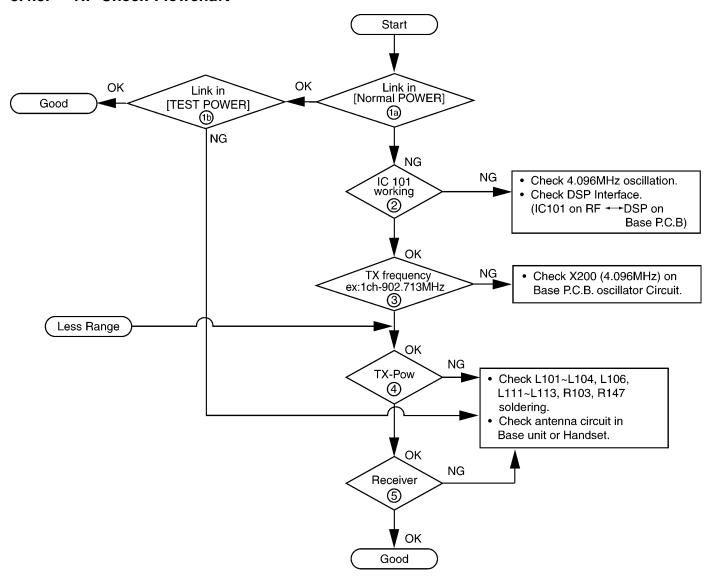


Fig. Using TC1703 BaseUnit-jig.

^{*} KX-TC1703 is used as the jig.

8.4.3. RF Check Flowchart



(a) ~ (5): Details of confirmation items are following in "8.4.4. Check Table for RF Block (P.27)".

NOTE:

<Base Unit>

EEPROM is IC551.

DSP is IC501.

<Handset>

EEPROM is IC202.

DSP is IC201.

8.4.4. Check Table for RF Block

No	Item		BS (Base unit) (*1)	HS (Handset) (*1)	
1a.	Link confirmation	Procedure	1. Put "HS JIG" on BS.	1. Put HS on "BS JIG".	
	[NORMAL POWER]		Set MODE to [NORMAL POWER] position of "HS JIG".	Set MODE to [NORMAL POWER] position of "BS JIG".	
			Press [TALK] key of "HS JIG" to establish link.	3. Press [TALK] key of "HS" to establish link.	
1b.	Link confirmation [TEST POWER]	Procedure	Change MODE to [TEST POWER] position of "HS JIG".	Change MODE to [TEST POWER] position of "BS JIG".	
			Press [TALK] key of "HS JIG" to establish link about 30cm away from "BS".	2. Press [TALK] key of "HS" to establish link about 30cm away from "BS JIG".	
2	IC101 working confirmation	Procedure	Set Test-mode [Continuos Send Low Power].(*3)	Set Test-mode [Continuos Send Low Power].(*3)	
			2. Confirm oscillate signal (4.096 MHz at Pin 33). (*4)	2. Confirm oscillate signal (4.096 MHz at Pin 33). (*4).	
		Check point	1. Check Pin 33 oscillator.	1. Check Pin 33 oscillator.	
			 Check DSP interface(IC101←→DSP/BS) (*5). 	2. Check DSP interface(IC101←→DSP/HS) (*5).	
3	TX frequency confirmation	Procedure	1. Set Test-mode [Continuos Send].(*3)	Set Test-mode [Continuos Send Low Power].(*3)	
	Commination		2. Confirm TX-carrier frequency (1CH = 902.713MHz ± 20kHz).	2. Confirm TX-carrier frequency (1CH = 902.713MHz ± 20kHz).	
		Check point	Check DSP or X200 oscillator Circuit.	1. Check DSP or X201 oscillator Circuit.	
4	TX Power confirmation	Procedure	Put RF wire to ANT and ANT_GND (See 9.4. Base Unit Reference Drawing).	Put RF wire to ANT and ANT_GND (See 9.5. Handset Reference Drawing).	
			Connect this wire Marconi or Spectrum Analyzer.	2. Set Test-mode .	
			2. Set Test-mode .	3. Confirm TX power level within -3±5dBm (*2)	
			3. Confirm TX power level within -3±5dBm (*2)	(0.158~1.58mW)	
			(0.158~1.58mW)		
		Check point	1. Check C102~C103, C161, L102, L111, R147 soldering.	1. Check C102~C103, C161, L102, L111, R147 soldering.	
			2. Check Antenna in BS.	2. Check Antenna in HS.	
5	Receiver	Procedure	1. Put "HS JIG" on BS.	1. Put HS on "BS JIG".	
	confirmation		Set MODE to [NORMAL POWER] position of "HS JIG".	Set MODE to [NORMAL POWER] position of "BS JIG".	
			3. Press [TALK] key of "HS JIG" to establish	3. Press [TALK] key of "HS" to establish link.	
			link. 4. Change MODE to [TEST POWER] position	Change MODE to [TEST POWER] position of "BS JIG".	
		of "HS JIG". 5. Press [TALK] key of "HS JIG" to establish		5. Press [TALK] key of "HS" to establish link	
			link about 30cm away from "BS".	about 30cm away from "BS JIG".	
		Check point	1. Check L103, L104, L106, L111~L113, X101, C103~C106, C110, C118, R103 soldering.	1. Check L103, L104, L106, L111~L113, X101, C103~C106, C110, C118, R103 soldering.	
			2. Check Antenna in BS.	2. Check Antenna in HS.	

(*1) BS: Base unit, HS: Handset unit, HS JIG: Handset-jig,

BS JIG: Base unit-jig

(*2)<Marconi setting>

TX Freq.; 902.713MHz mode; WB

<Spectrum analyzer setting>

Freq. 902.713MHz Span 10MHz

RBW 1MHz or above VBW same as RBW

(*3)See **9 TEST MODE (** P.30).

(*4)See 8.4.5. RF-DSP interface signal wave form (P.28).

(*5)See 9.4. Base Unit Reference Drawing (P.32).

See 9.5. Handset Reference Drawing (P.33).

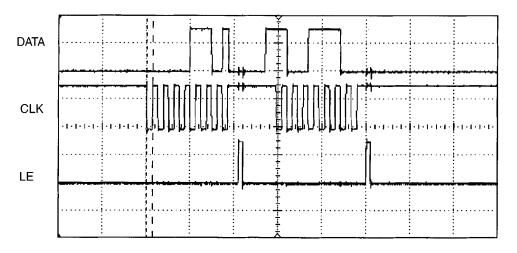
NOTE:

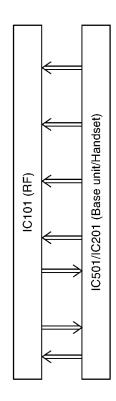
Flash Memory is IC300.

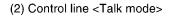
DSP is IC501 (Base Unit) / IC201 (Handset).

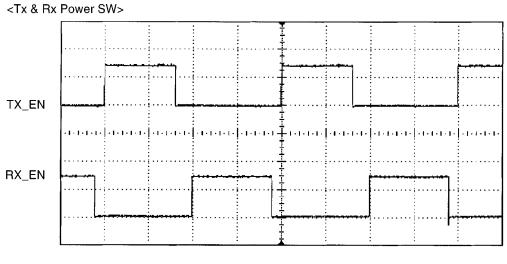
8.4.5. RF-DSP interface signal wave form

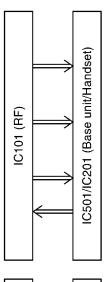
(1) Serial control line <Standby mode>

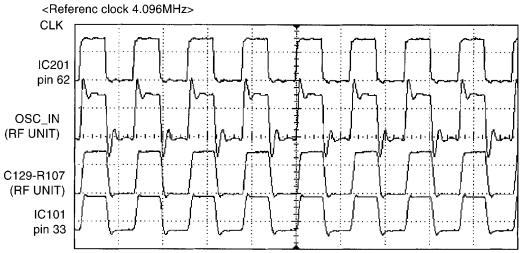


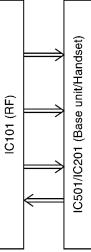




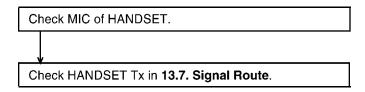








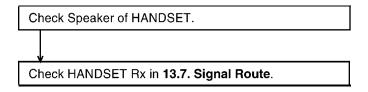
8.5. Check Handset Transmission



Cross Reference:

13.7. Signal Route (P.44).

8.6. Check Handset Reception



Cross Reference:

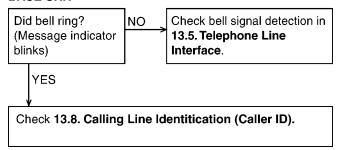
13.7. Signal Route (P.44).

NOTE:

When checking the RF UNIT, Refer to **8.4. Check the RF** Unit (P.24)

8.7. Check Call ID

BASE UNIT



Cross Reference:

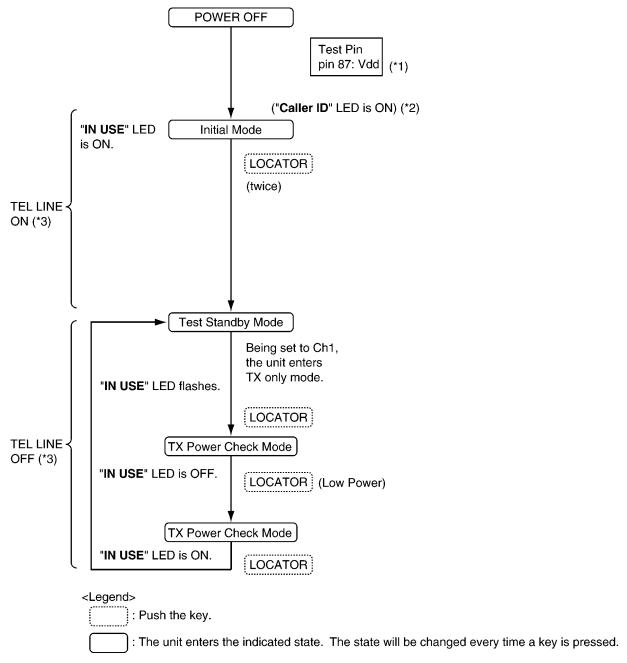
- 13.5. Telephone Line Interface (P.42).
- 13.8. Calling Line Identification Circuit (Caller ID) (P.45).

Note:

- Make sure the format of the Caller ID or Call Waiting Caller ID service of the Telephone company that the customer subscribed to.
- Also we recommend to confirm that the customer is really a subscriber of the service.

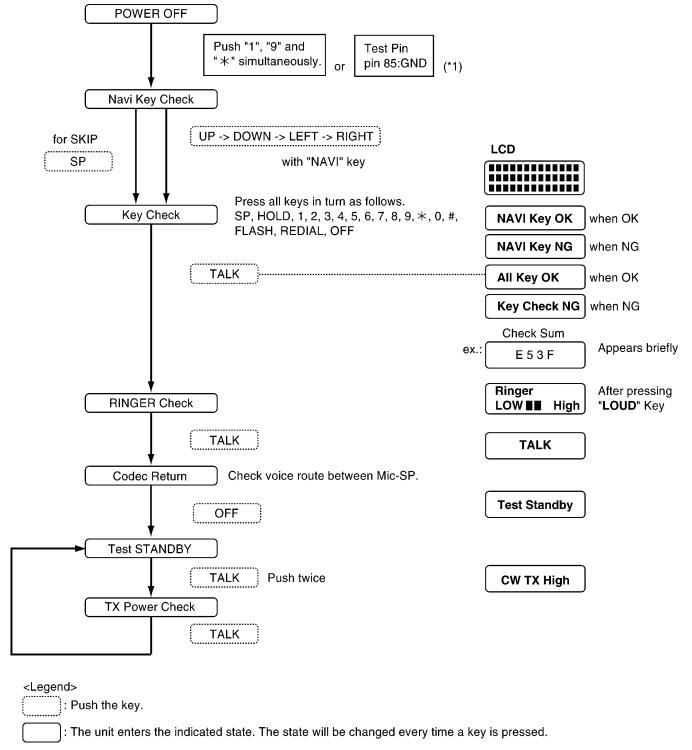
9 TEST MODE

9.1. Test mode flow chart for Base Unit



- (*1) See **9.4. Base Unit Reference Drawing** (P.32) Insert AC adaptor for entering the test mode during pressing the test switch
- (*2) While the Tele line is connected, the "Caller ID" LED is ON/OFF as well.
- (*3) It shows whether the telephone line is connected or not.
- -ON: OFF HOOK. -OFF: ON HOOK

9.2. Test mode flow chart for Handset



(*1) See 9.5. Handset Reference Drawing (P.33).---Insert Battery for entering the Test mode during pressing the test switch.

9.3. X101 Check

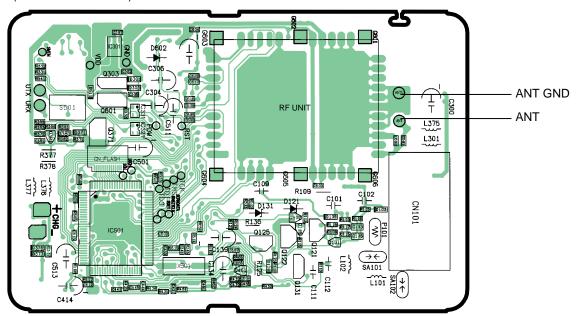
The confirmation is made under the Continuous Send mode of TEST MODE.

Equipment: Frequency counter TP for adjustment: TP_ANT

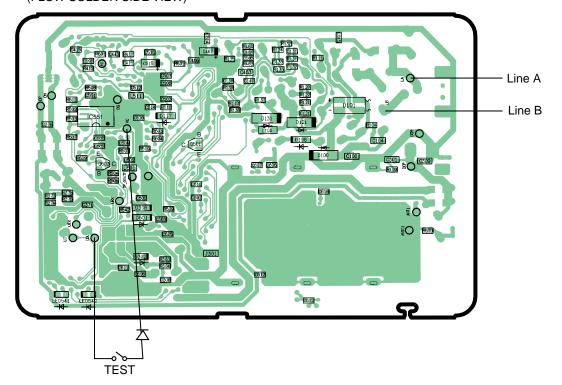
Measure range: 902.713 MHz ± 5 kHz (1ch) at Test Standby mode in 9 TEST MODE (P.30).

9.4. Base Unit Reference Drawing

(COMPONENT VIEW)



(FLOW SOLDER SIDE VIEW)



1000 WW-o o TEST PULL UP SP+ HANDSET (COMPONENT VIEW) ANT GND -ANT

Handset Reference Drawing 9.5.

9.6. FREQUENCY TABLE

(TDD: time division duplex)

Channel	TX/RX Frequency (MHz)	Channel	TX/RX Frequency (MHz)
1	902.713	12	925.013
2	902.940	13	925.241
3	903.168	14	925.468
4	903.395	15	925.696
5	903.623	16	925.923
6	903.850	17	926.151
7	904.078	18	926.378
8	904.305	19	926.606
9	904.533	20	926.833
10	904.761	21	927.061
11	904.988	22	927.289

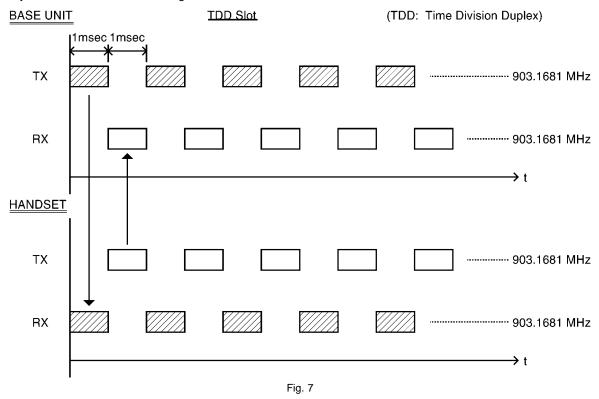
10 DESCRIPTION

10.1. Frequency

The frequency range of 902.713 MHz ~ 927.289 MHz is used. Transmitting and receiving channel between base unit and handset is same frequency. Refer to the Frequency Table.

10.2. Time Division Duplex (TDD) operation

Transmission/reception between the base unit and handset is performed by time-sharing as shown in Fig. 7. 1 slot time of transmission and reception is 1mS.Same frequency is used in transmitting and receiving. The figure shows an example; the frequency of 3ch is used in transmitting between the base unit and handset.

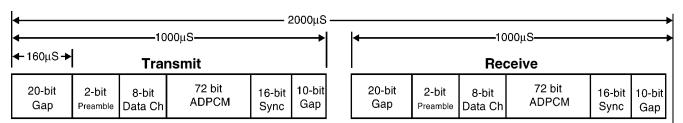


10.2.1. TDD Frame Format

The TDD frame is 2mS in length. Each subframe contains 128 bits of 7.8µS duration.

Each subframe consists of the following four fields:

- · A 2-bit Preamble field
- · An 8-bit Data Channel field
- · An 16-bit Sync Word
- · A 72-bit ADPCM Payload (CRC 8-bit)



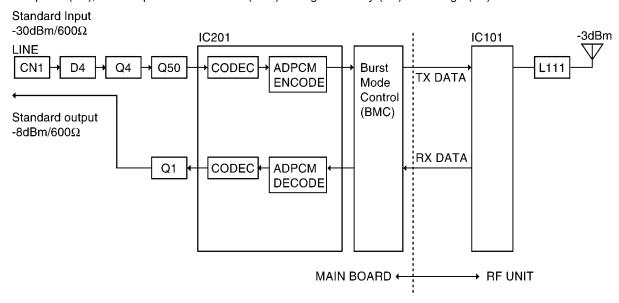
10.3. Signal Flowchart in the Whole System

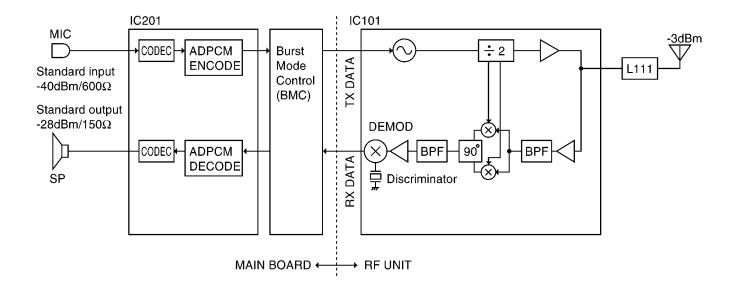
Reception

CN1 of the base unit is connected to the TEL line, and the signal is input through the bridge diode D101. While talking the relay (Q121) is turned ON and amplified at the amplifiers Q50, then led to DSP (IC201). DSP generates ADPCM signal. The ADPCM signal is input to RFIC (IC101) of RF UNIT. RFIC outputs FSK modulated RF signal. The RF signal is passed through filter (L111) to be transmitted from the antenna. As for the handset, RF signal from the antenna is input to RFIC passing through filter (L111) then input to DSP (IC201). DSP performs ADPCM decoding to convert the signal into the voice signal, then it is output to the speaker.

Transmission

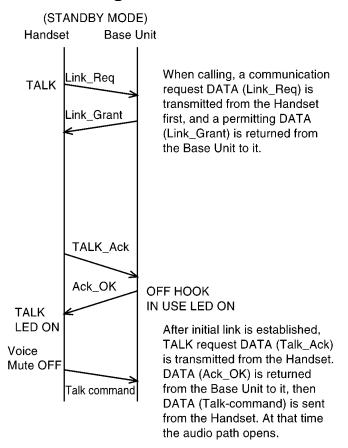
The voice signal input from the microphone is led to DSP (IC201). The DSP generates ADPCM signal. As well as the reception, it is converted into the RF signal by RFIC (IC101). Passing through filter (L111), it is transmitted from the antenna. As for the base unit, RF signal from the antenna is input to RFIC (IC101) passing through filter (L111) and the balum then input to DSP (IC201). DSP performs ADPCM decoding to convert the signal into the voice signal. The voice signal is amplified at the TX amplifier (Q1), then output to the TEL line (CN1) through the relay (Q4) and bridge (D4).



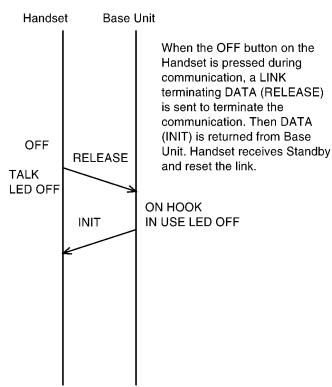


11 EXPLANATION OF BBIC (Base Band IC) DATA COMMUNICATION

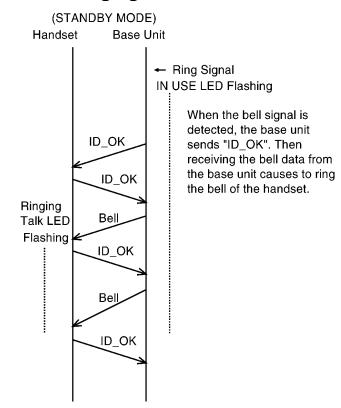
11.1. Calling



11.2. To Terminate Communication



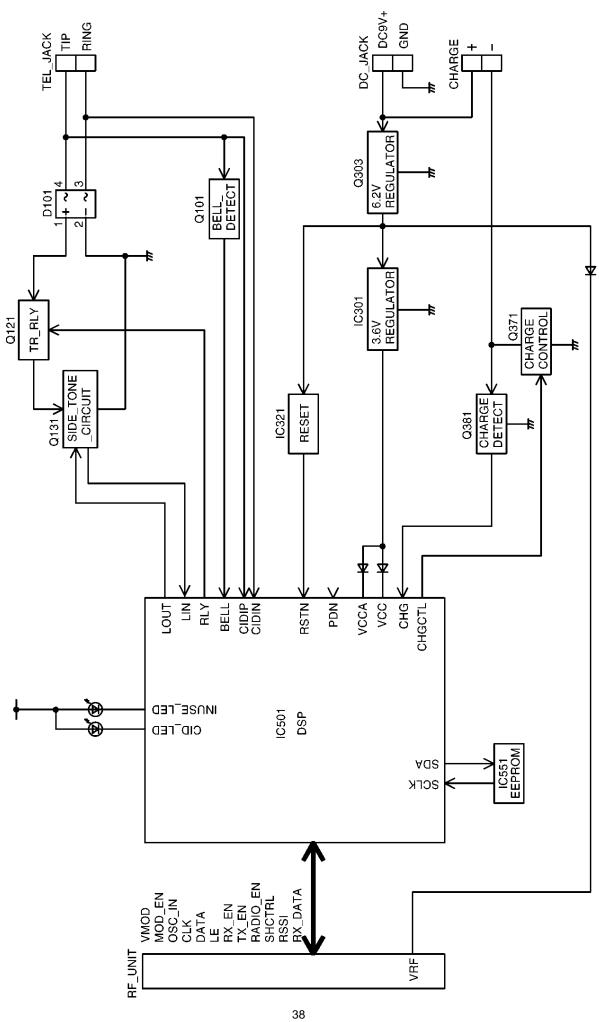
11.3. Ringing



11.4. Ports for Transmitting and Receiving of Data

Handset: (IC201) TransmittingReceiving		
Base Unit: (IC501) Transmitting Receiving	Pin 57	

12 BLOCK DIAGRAM (Base Unit)



13 CIRCUIT OPERATION (Base Unit)

General Description:

(DSP, Flash Memory) is a digital speakerphone/speech/signal processing system that implements all the functions of speech compression, record and playback, and memory management required in a digital telephone answering machine.

The DSP system is fully controlled by a host processor DSP. The host processor provides activation and control of all that functions as follows.

13.1. DSP (Digital Speech/Signal Processing: IC501)

· DTMF Detection/Generator

The DTMF detection is implemented by the DSP system in software. The DTMF detection is performed during Record, Playback, and Line Monitoring modes of operation.

When the DTMF data from the Handset is received, the DTMF signal is output.

· Caller ID and Call Waiting CID demodulation

The DSP implements monitor and demodulate the FSK signals that provide CID information from the Central Office.

· Analog Switching

The voice signal from telephone line is transmitted to the speaker or the voice signal from speakerphone microphone is transmitted to the Telephone line, etc. They are determined by the signal path route operation of voice signal.

· Block Interface Circuit

RF unit, LED, Key scan, Speaker, Microphone, Telephone line, LCD

13.2. **EEPROM (IC551)**

Following information data is stored.

· Telephone number, etc.

ex: Telephone Directory number, Caller ID data, ID code

· Settings

ex: message numbers, caller ID numbers, pulse tone dial

13.3. Power Supply Circuit

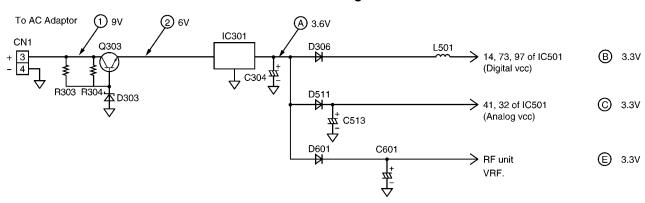
Function:

The power supply voltage from AC adaptor is converted to the desired voltage of each block.

Circuit Operation:

This unit supplies the voltage to each block as shown below.

Circuit Diagram



13.3.1. Charge Circuit

The voltage from the AC is supplied to the main charge circuits. Normal charge (70 mA) of maximum 20-hours is started soon after the Handset is placed on the base unit. Then it changes to trickle charge (15 mA on the average) to prevent from overcharging.

Normal charge : Q150 is ON Trickle charge : Q150 is OFF

Circuit Diagram 3.3V R384 R385 CHARGE (74) DET 3.6V GND **DSP** Q371 CHARGE (3) CONTROL C371 Q381 to H/S OCHG -R374 R375 R376

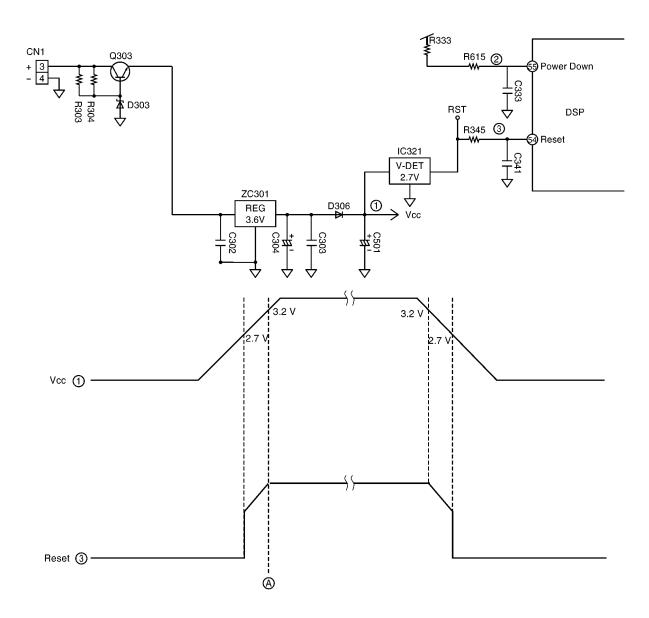
13.4. Reset Circuit

Function:

This circuit is used for to initialize the microcomputer when it incorporates an AC adaptor.

Circuit Operation:

When the AC Adaptor is inserted into the unit, then the voltage is shifted by IC301, D306 and power is supplied to the DSP. The set can operate beyond point (A) in the circuit voltage diagram.



13.5. Telephone Line Interface

Telephone Line Interface Circuit:

Function

- · Bell signal detection
- · ON/OFF hook and pulse dial circuit
- · Side tone circuit
- · Auto-disconnect circuit/Parallel connection detection circuit

Bell signal detection and OFF HOOK circuit:

In the idle mode, Q121 is open to cut the DC loop current and decrease the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

$$T \rightarrow L101 \rightarrow R103 \rightarrow C103 \rightarrow Q101 \rightarrow DSP pin 27. [BELL]$$

When the CPU (DSP) detects a ring signal, Q121 turns on, thus providing an off-hook condition (active DC current flow through the circuit) and the following signal flow is for the voice signal.

$$\mathsf{T} \to \mathsf{D}101 \to \mathsf{Q}121 \to \mathsf{R}140/\mathsf{R}139 \to \mathsf{C}139 \to \mathsf{R}138 \to \mathsf{R}136 \to \mathsf{D}131 \to \mathsf{D}101 \to \mathsf{L}102 \to \mathsf{P}101 \to \mathsf{R}$$

ON HOOK Circuit:

Q121 is open, Q121 is connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in an on-hook condition.

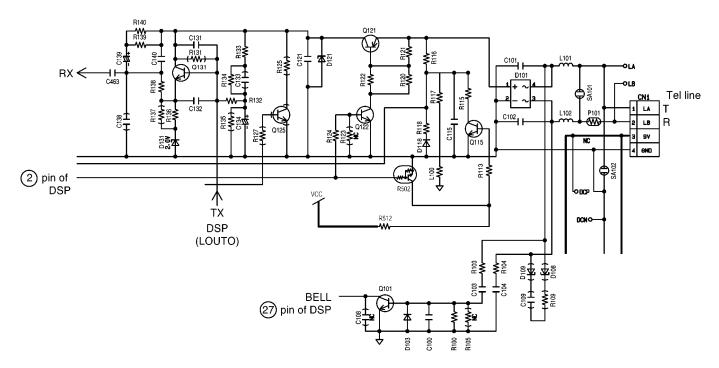
Pulse Dial Circuit:

DSP (2) turns Q121 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal.

As for this unit, TX signal feed back from Q131 is canceled by the chancellor circuit of DSP.



13.6. Parallel Connection Detect Circuit

Function:

In order to disable call waiting and stutter tone functions when using telephones connected in parallel, it is necessary to have a circuit that judges whether a telephone connected in parallel is in use or not. This circuit determines whether the telephone connected in parallel is on hook or off hook by detecting changes in the T/R voltage.

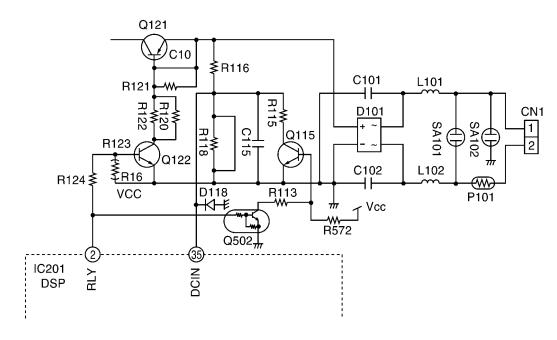
Circuit Operation:

Parallel connection detection when on hook:

When on hook Q115 is ON, the voltage is monitored DCIN of DSP. There is no parallel connection if the voltage is 1.65 V or higher, while a parallel connection is deemed to exist if the voltage is lower.

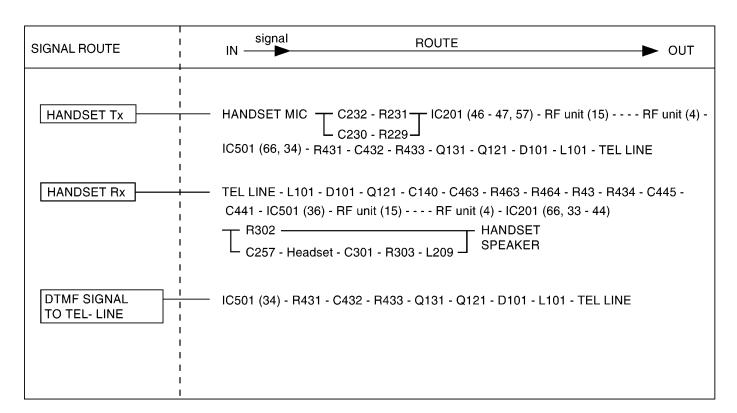
Parallel connection detection when off hook:

When off hook Q115 is OFF, the voltage is monitored DCIN of DSP; the presence/absence of a parallel connection is determined when the voltage changes by 0.2 V or more.



13.7. Signal Route

Each signal route is as follows.



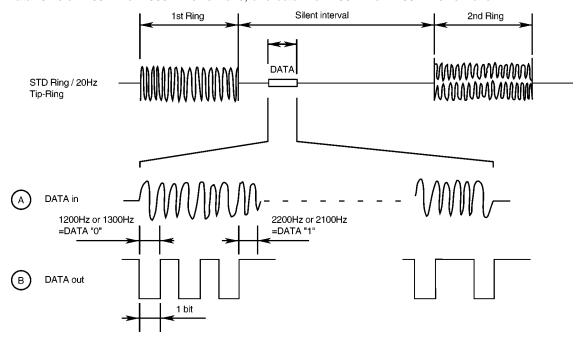
13.8. Calling Line Identification Circuit (Caller ID)

Function:

The caller ID is a chargeable ID which the user of a telephone circuit obtains by entering a contract with the telephone company to utilize a caller ID service. For this reason, the operation of this circuit assumes that a caller ID service contract has been entered for the circuit being used. This model can receive 2 types of caller ID (FSK type, DTMF type).

· FSK type

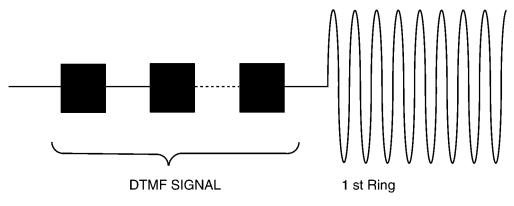
The data for the caller ID from the telephone exchange is sent during the interval between the first and second rings of the bell signal. The data from the telephone exchange is a modem signal which is modulated in an FSK (Frequency Shift Keying) format. Data "0" is a 1200 Hz or 1300 Hz sine wave, and data 1 a 2200 Hz or 2100 Hz sine wave.



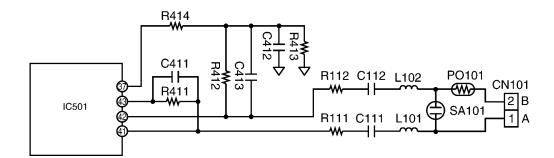
KX-TC1709LBB

• DTMF type

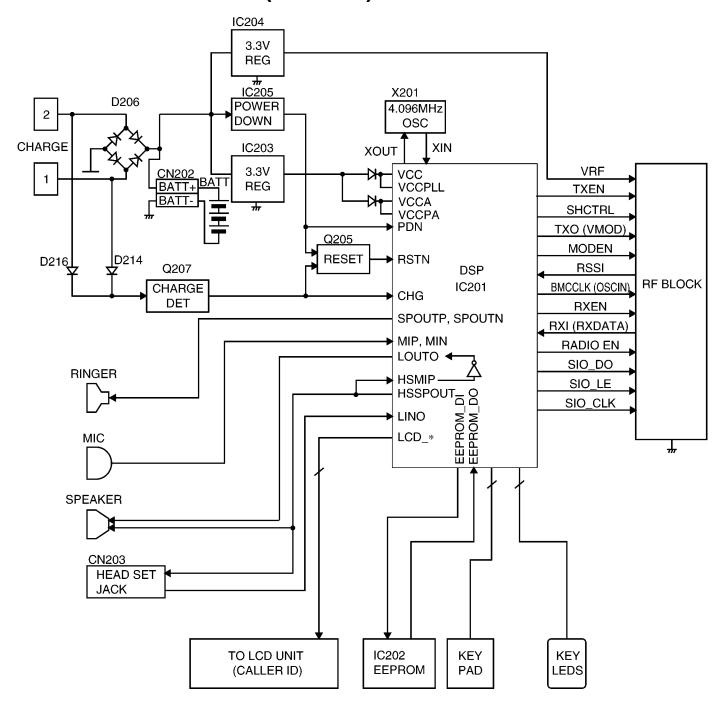
The data for the caller ID from the telphone exchange is DTMF signal. It is sent before the first ring of bell signal.



Circuit Diagram



14 BLOCK DIAGRAM (Handset)



15 CIRCUIT OPERATION (Handset)

15.1. Construction

The circuit mainly consists of DSP and RF unit as shown in the block diagram.

15.1.1. DSP:IC201

Function

- · Battery Low, Power down defect circuit
- · Ringer Generation
- · Interface circuit

RF unit, speaker, mic, LED, Key scan, LCD, Headset

15.1.2. RF unit

Mainly voice signal is modulated to RF, or it goes the other way.

15.1.3. **EEPROM**: IC202

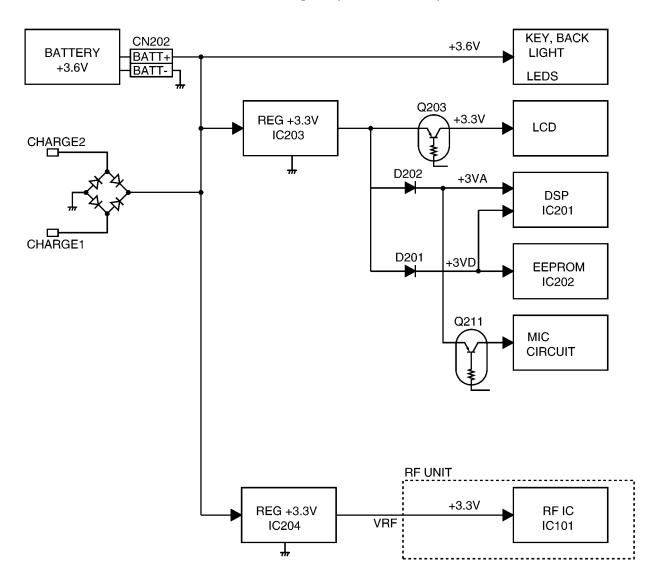
All setting data is stored.

ex: ID code, user setting (Flash Time, Tone/Pulse)

15.2. Power Supply Circuit

Voltage is supplied separately to each block as shown Block Diagram.

Block Diagram (Handset Power)



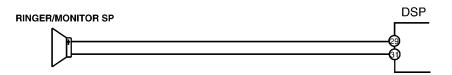
15.3. Charge Circuit

Ni-Cd battery is connected to CN202. When the handset is put on the cradle of the base unit, the power is supplied from CHARGE1 and CHARGE2 terminals to charge the battery. Q207 detects the voltage of CHARGE1 and CHARGE2 terminals, then the handset makes ID code setting with the base unit.

15.4. Ringer and Handset SP-Phone

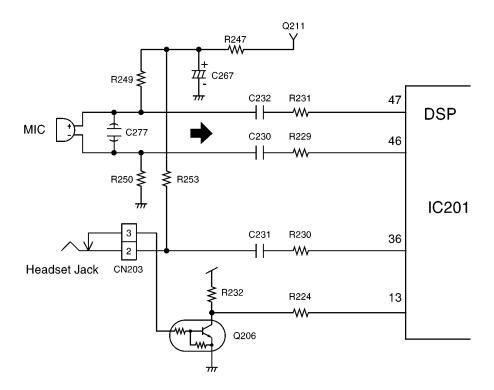
DSP (29-31) → SP/RINGER

Circuit Diagram



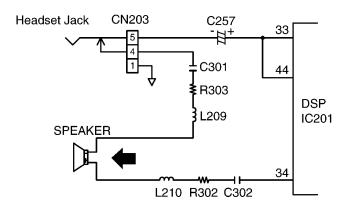
15.5. Sending Signal

The voice signal from the microphone input to DSP (46-47). CN203 is the headset jack. When the headphone is connected, the Q206 detect it. The input from the microphone of the handset (MIN, MIP) is cut and the microphone signal from the headphone is input to DSP (36). Also the power for the microphone is supplied from Q211, and the power is turned OFF on standby.



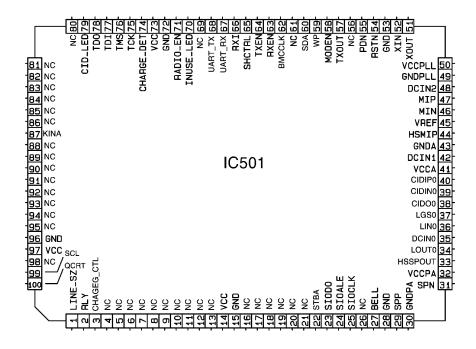
15.6. Reception Signal

The voice signal from the base unit is output to DSP (33) (HSSOUT). This signal is led to the headset jack (CN203) and DSP (44) (HSMIP). The signal input to DSP (44) is inverted and output to DSP (34) (LOUTO). The signal through the headset jack is inverted, then output from DSP (34) to drive the speaker. When the headset is inserted to the jack, the voice signal is cut at the jack, so the sound does not come out from the speaker, but from the headset only.



16 CPU DATA (Base Unit)

16.1. IC501

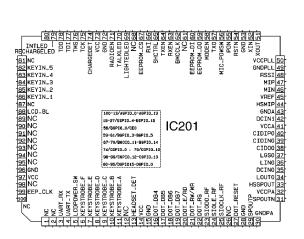


Pin	Description	I/O	High	Hi-z	Low
1	LINE SZ	D.O	On		Off
2	RLY	D.O	On		Off
3	CHAGEG_CTL	D.O		Charge	Non Charge
4	NC	D.O			Normal
5	NC	D.O			Normal
6	NC	D.O			Normal
7	NC	D.O			Normal
8	NC	D.O			Normal
9	NC	D.O			Normal
10	NC	D.O			Normal
11	NC	D.O			Normal
12	NC	D.O			Normal
13	NC NC	D.O			Normal
14	VCC	VCC	Vcc		
15	GND	GND			GND
16	NC	D.O			Normal
17	NC NC	D.O			Normal
18	NC NC	D.O			Normal
19	NC NC	D.O			Normal
20	NC NC	D.O			Normal
					Normal
21	NC .	D.O	 A - C		
22	STBA	D.O	Active	Not	
23	SIOD0	D.O			
24	SIOALE	D.O			
25	SIOCLK	D.O			
26	NC	D.O			Normal
27	BELL	D.I	Off		On
28	GND	GND			GND
29	SPP	A.O			
30	GNDPA	GND			GND
31	SPN	A.O			
32	VCCPA	VCC	VCC		
33	HSSPOUT	A.O			
34	LOUT0	A.O			
35	DCIN0	A.I			
36	LIN0	A.I			
37	LGS0	A.I			
38	CIDO0	A.I			
39	CIDIN0	A.I			
40	CIDIP0	A.I			
41	VCCA	VCC	VCC		
42	DCIN1	A.I			
43	GNDA	GND			GND
44	HSMIP	A.I			
45	VREF	A.O			
46	MIN	A.I			
47	MIP	A.I			
48	DCIN2	A.I			
49	GNDPLL	GND			GND
50	VCCPLL	VCC	VCC		

	l 5 ·	I ./o	I I		
Pin	Description	I/O	High	Hi-z	Low
51	XOUT	A.O			
52	XIN	A.I			
53	GND	GND			GND
54	RSTN	D.I	Normal		Reset
55	PDN	D.I	Power On		Power Down
56	NC	D.O			Normal
57	TXOUT	D.O			
58	MODEN	D.I			
59	WP	D.O	WP		Write
60	SDA	D.O	High		Low
61	NC	D.O			Normal
62	BMCCLK	D.O			
63	RXEN	D.O			
64	TXEN	D.O			
65	SHCTRL	D.O			
66	RXI	D.I			
67	UART_RX	D.I	High		Low
68	UART_TX	D.Q	High		Low
69	NC	D.O			Normal
70	INUSE_LED	D.O		off	On
71	RADIO_EN	D.O			
72	GND	GND			GND
73	VCC	VCC	VCC		
74	CHARGE_DET	D.I	Off Charge		On Charge
75	TCK	D.O			
76	TMS	D.O			
77	TDI	D.I			
78	TDO	D.O			
79	CID_LED	D.O		off	On
80	NC	D.O			Normal
81	NC	D.O			Normal
82	NC	D.O			Normal
83	NC	D.O			Normal
84	NC	D.O			Normal
85	NC	D.O			Normal
86	NC	D.O			Normal
87	KINA	D.I	Key In		Non
88	NC	D.O	 - 		Normal
89	NC	D.O			Normal
90	NC	D.O			Normal
91	NC	D.O			Normal
92	NC	D.O			Normal
93	NC	D.O			Normal
94	NC	D.O			Normal
95	NC	D.O			Normal
96	GND	GND			GND
97	VCC	VCC	VCC		
98	NC	D.Q			Normal
99	SCL	D.O	High		Low
100	QCRT	D.O	STOP		Normal

17 CPU DATA (Handset)

17.1. IC201

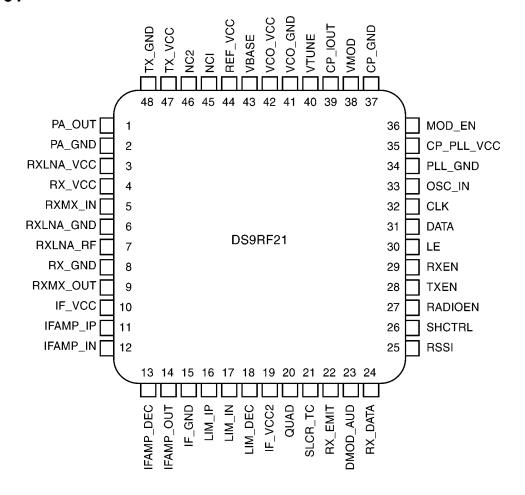


Pin	Description	I/O	High	High_Z	Low
1	NC	D.Q	-	-	Normal
2	NC	D.O	-	-	Normal
3	UART_RX	D.I	High	-	Low
4	UART_TX	D.O	High	-	Low
5	LCDPOWER_SW	D.O	Off	-	On
6	KEYSTROBE_F	D.O	-	Not	Active
7	KEYSTROBE_E	D.O	-	Not	Active
8	KEYSTROBE_D	D.O	-	Not	Active
9	KEYSTROBE C	D.Q	-	Not	Active
10	KEYSTROBE B	D.O	-	Not	Active
11	KEYSTROBE A	D.O	-	Not	Active
12	NC _	D.O	-	-	Normal
13	HEADSET_DET	D.I	Headset In	_	Non
14	vcc _	VCC	l vcc l	_	-
15	GND	GND	-	_	GND
16	DOT_DB4	D.O	High	_	Low
17	DOT DB5	D.O	High	_	Low
18	DOT_DB6	D.O	High	_	Low
19	DOT_DB7	D.O	High	_	Low
20	DOT_E/RD	D.O	Active	_	Not
21	DOT_RW/WR	D.O	Read	_	Write
22	DOT_RS	D.O	Data	_	Instruct
23	SIODO_RF	D.O	High	_	Low
24	SIOLE RF	D.O	Latch	_	Not
25	SIOCLK_RF	D.O	High	_	Low
26	NC	D.O	'"g''	_	Normal
27	DOT_RESET	D.O	Nomal	_	Reset
28	GND	GND	Nomai	_	GND
29	SPOUTP	A.O	_	_	-
30	GNDPA	GND	_	_	GND
31	SPOUTN	A.O	_	_	-
32	VCCPA	VCC	vcc	_	
33	HSSPOUT	A.O	"-	- -	_
34	LOUTO	A.O		_	_
35	DCINO	A.I	-	_	_
36	LINO	A.I	-	_	_
37	LGSO	A.I	[_	
38	CIDOO	A.I	- I	=	-
39	CIDINO	A.I	-	_	_
40	CIDINO	A.I A.I	-	-	-
41	VCCA	VCC	vcc	-	_
42				-	-
	DCIN1	A.I	-	-	GND
43	GNDA	GND	-	-	GND
44	HSMIP	A.I	-	-	-
45	VRFF	A.O	•	-	-
46	MIN	A.I	-	-	-
47	MIP	A.I	-	-	-
48	RSSI	A.I	-	-	-
49	GNDPLL	GND		-	GND
50	VCCPLL	VCC	vcc	-	-

			1		
Pin	Description	1/0	High	High_Z	Low
51	XOUT	A.O	-	-	-
52	XIN	A.I	-	-	-
53	GND	GND		-	GND
54	RSTN	D.I	Normal	-	Reset
55	PDN	D.I	Power On	-	Power Down
56	MIC_POWSW	D.O	Bias Off	-	Bias On
57	TXO	D.O	-	-	-
58	MODEN	D.O	-	-	-
59	EEPROM_DO	D.I	High	-	Low
60	EEPROM_DI	D.O	High	-	Low
61	NC	D.O	-	-	Normal
62	BMCCLK	D.O	-	-	-
63	RXEN	D.O	-	-	-
64	TXEN	D.O	-	-	-
65	SHCTRL	D.O	-	-	-
66	RXI	D.I	-	-	-
67	EEPROM_CS	D.O	Active	-	Not
68	NC	D.O	-	-	Normal
69	LIGHTEDLED	D.O	On	-	Off
70	TALK LED	D.O	Normal	-	On
71	RADIOEN	D.O	-	-	-
72	GND	GND		-	GND
73	VCC	VCC	VCC	-	- -
74	CHAGEDET	D.I	Off Charge	-	On Charge
75	TCK	D.O	-	-	-
76	TMS	D.O	-	-	-
77	TDI	D.I	-	-	-
78	TDO	D.O	·	-	_
79	RECHARGELED	D.O	Normal	-	On
80	INTLED	D.O	Normal	-	On
81	NC	D.O	Normal	-	
82	KEYIN_5	D.I	Non	-	Key In
83	KEYIN_4	D.I	Non	-	Key In
84	KEYIN_3	D.I	Non	-	Key In
85	KEYIN_2	D.I	Non	-	Key In
86	KEYIN_1	D.I	Non	-	Key In
87	NC	D.O	Normal	-	Normal
88	LCD_BL	D.O	On	-	Off
89	NC	D.O	-	-	Normal
90	NC	D.O	-	-	Normal
91	NC	D.O	-	-	Normal
92	NC	D.O	-	-	Normal
93	NC	D.O	-	-	Normal
94	NC	D.O	-	-	Normal
95	NC	D.O	-	-	Normal
96	GND	GND	\	-	GND
97	VCC	VCC	VCC	-	
98	NC	D.O	-	-	Normal
99	EPP_CLK	D.O	High	-	Low
100	NC	D.O		-	Normal

18 EXPLANATION OF IC TERMINALS (RF Unit)

18.1. IC101



Description	1/0
PA_OUT	0
PA_GND	0
	O&VCC
RX_VCC	VCC
RXMX_IN	I
RXLNA_GND	GND
RXLNA_RF	1
RX_GND	GND
RXMX_OUT	O&VCC
IF_VCC	VCC
IFAMP_IP	ı
IFAMP_IN	1
IFAMP_DEC	1
IFAMP_OUT	0
IF_GND	GND
LIM_IP	I
LIM_IN	I
LIM_DEC	I
IF_VCC2	VCC
QUAD	1
SLCR_TC	I
RX_EMIT	GND
DMOD_AUD	0
RX_DATA	0
	PA_OUT PA_GND RXLNA_VCC RX_VCC RXMX_IN RXLNA_GND RXLNA_RF RX_GND RXMX_OUT IF_VCC IFAMP_IP IFAMP_IN IFAMP_DEC IFAMP_OUT IF_GND LIM_IP LIM_IN LIM_DEC IF_VCC2 QUAD SLCR_TC RX_EMIT DMOD_AUD

Pin	Description	I/O
25	RSSI	0
26	SHCTRL	1
27	RADIOEN	1
28	TXEN	I
29	RXEN	1
30	LE	1
31	DATA	1
32	CLK	1
33	OSC_IN	ı
34	PLL_GND	GND
35	CP_PLL_VCC	VCC
36	MOD_EN	1
37	CP_GND	GND
38	VMOD	1
39	CP_IOUT	0
40	VTUNE	I
41	VCO_GND	GND
42	vco_vcc	VCC
43	VBASE	1
44	REF_VCC	VCC
45	NCI	N/C
46	NC2	N/C
47	TX_VCC	VCC
48	TX_GND	GND

19 HOW TO REPLACE FLAT PACKAGE IC

19.1. Preparation

· SOLDER

Sparkle Solder 115A-1, 115B-1 or Almit Solder KR-19, KR-19RMA

· Soldering iron

Recommended power consumption will be between 30 W to 40 W.

Temperature of Copper Rod 662 ± 50°F (350 ± 10°C)

(An expert may handle between 60 W to 80 W iron, but beginner might damage foil by overheating.)

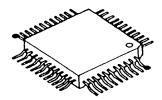
Flux

HI115 Specific gravity 0.863.

(Original flux will be replaced daily.)

19.2. Procedure

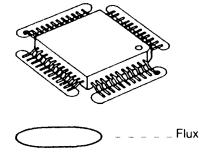
 Temporary fix FLAT PACKAGE IC by soldering on two marked 2 pins.



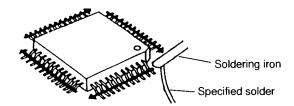
• - - - - - Temporary soldering point.

*Most important matter is accurate setting of IC to the corresponding soldering foil.

2. Apply flux for all pins of FLAT PACKAGE IC.



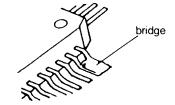
3. Solder employing specified solder to direction of arrow, as sliding the soldering iron.

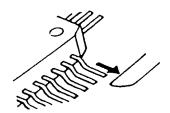


19.3. Modification Procedure of Bridge

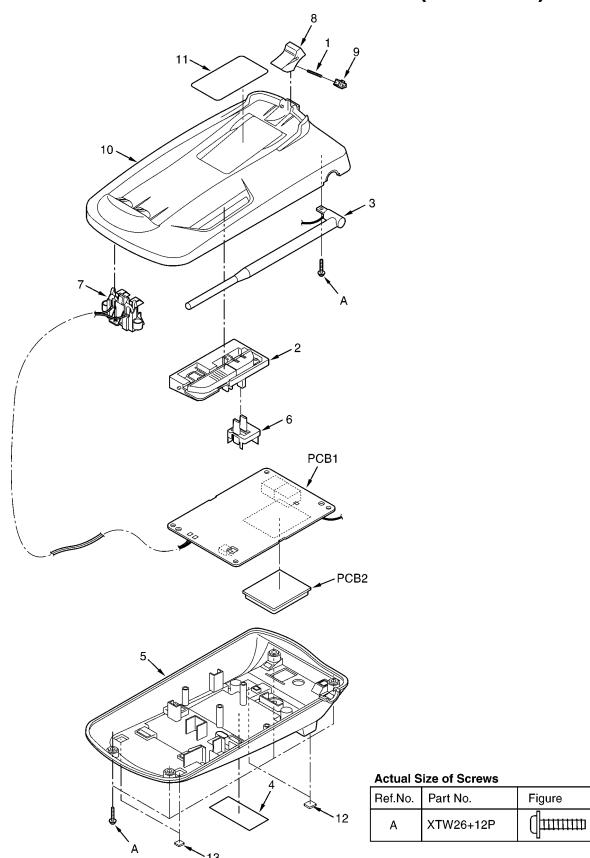
- 1. Re-solder slightly on bridged portion.
- 2. Remove remained solder along pins employing soldering

iron as shown in below figure.

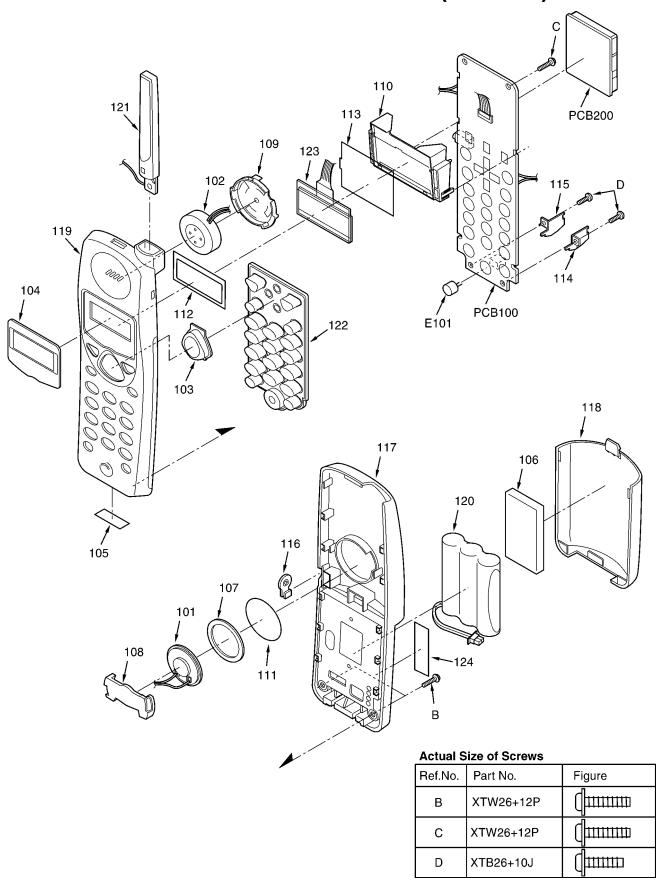




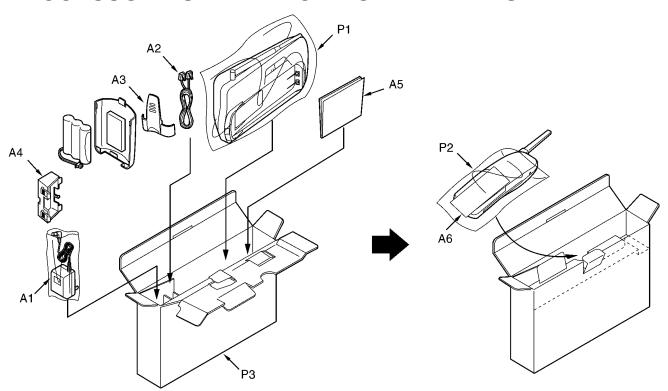
20 CABINET AND ELECTRICAL PARTS (Base Unit)



21 CABINET AND ELECTRICAL PARTS (Handset)

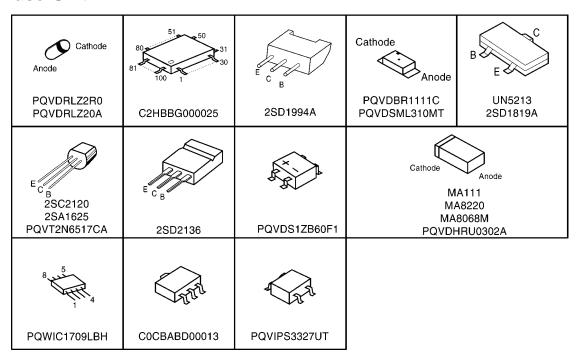


22 ACCESSORIES AND PACKING MATERIALS

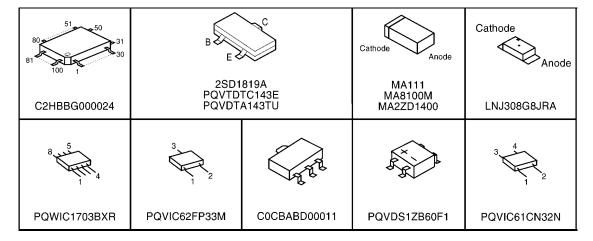


23 TERMINAL GUIDE OF IC'S, TRANSISTORS AND DIODES

23.1. Base Unit



23.2. Handset



24 REPLACEMENT PARTS LIST

This replacement parts list are KX-TC1709LBB only. Note:

1. RTL (Retention Time Limited)

The marking (RTL) indicates that the Retention Time is limited for this item.

After the discontinuation of this assembly in production, the item will continue to be available for a specific period of time. The retention period of availability is dependent on the type of assembly, and in accordance with the laws governing part and product retention.

After the end of this period, the assembly will no longer be available.

2. Important safety notice

Components identified by a \triangle mark special characteristics important for safety. When replacing any of these components, use only manufacture's specified parts.

3. The S mark indicates service standard parts and may differ from production parts.

4. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) K=1000 Ω , M=1000k Ω

All capacitors are in MICRO FARADS (μF) P=μμF

*Type & Wattage of Resistor

Type

ERC:Solid	ERX:Metal Film	PQ4R:Carbon
ERD:Carbon	ERG:Metal Oxide	ERS:Fusible Resistor
PQRD:Carbon	ER0:Metal Film	ERF:Cement Resistor
Wattene		

1:1W

2:2W 3:3W

ECFD:Semi-Conductor	ECCD,ECKD,ECBT,PQCBC:Ceramic
ECQS:Styrol	ECQE,ECQV,ECQG:Polyester
PQCUV:Chip	ECEA,ECSZ:Electlytic
ECQMS:Mica	ECQP:Polypropylene

Voltage

ECQ Type	ECQG	ECSZ Type	Othe	rs
	ECQV Type			
1H:50V	05:50V	0F:3.15V	0J :6.3V	1V :35V
2A:100V	1:100V	1A:10V	1A :10V	50,1H:50V
2E:250V	2:200V	1V:35V	1C :16V	1J :63V
2H:500V		0J:6.3V	1E,25:25V	2A :100V

24.1. Base Unit

24.1.1. CABINET AND ELECTRICAL PARTS

Ref. No.	Part No.	Part Name & Description	Remarks
1	PQUS10285Z	HOOK SPRING	
2	PQBC10338Z1	LOCATOR BUTTON	s
3	PQSA10095Z	ANTENNA	
4	PQGT14771Z	NAME PLATE	
5	PQKF10519Y1	LOWER CABINET	s
6	PQHR10857Z	LED PLATE	

Ref. No.	Part No.	Part Name & Description	Remarks
7	PQWE10022Z	CHARGE TERMINAL	
8	PQKE10131Z1	HOOK LEVER	s
9	PQKE10134Z1	HOOK KNOB	s
10	1AKM10487Z3	UPPER CABINET	s
11	PQQT22278Z	CHARGE LABEL	
12	PQHA10017Z	LEG CUSHION RUBBER	
13	PQHA10018Z	FOOT RUBBER	

24.1.2. MAIN P.C. BOARD PARTS

Ref. No.	Part No.	Part Name & Description	Remarks
PCB1	PQWPC1709LBH	MAIN P.C.BOARD ASS'Y (RTL)	
		(ICS)	
IC301	COCBABD00013	IC	
IC321	PQVIPS3327UT	IC	
IC501	C2HBBG000025	IC	
IC551	PQWIC1709LBH	IC	
		(TRANSISTORS)	
Q101	2SD1819A	TRANSISTOR(SI)	
2115	2SD1819A	TRANSISTOR(SI)	
Q121	2SA1625	TRANSISTOR(SI)	s
Q122	PQVT2N6517CA	TRANSISTOR(SI)	s
Q131	2SC2120	TRANSISTOR(SI)	s
Q303		<u> </u>	+
	2SD2136	TRANSISTOR(SI)	
Q371	2SD1994A	TRANSISTOR(SI)	
Q381	2SD1819A	TRANSISTOR(SI)	
Q461	2SD1819A	TRANSISTOR(SI)	
Q501	2SD1819A	TRANSISTOR(SI)	
Q502	UN5213	TRANSISTOR(SI)	s
		(DIODES)	
D101	PQVDS1ZB60F1	DIODE(SI)	
D103	MA111	DIODE(SI)	
D117	MA111	DIODE(SI)	
D118	MA111	DIODE(SI)	
D121	PQVDRLZ20A	DIODE(SI)	s
D131	PQVDRLZ2R0	DIODE(SI)	s
D303	MA8068M	DIODE(SI)	
D306	PQVDHRU0302A	DIODE(SI)	s
D376	MA8220	DIODE(SI)	+
D370 D377			
	MA8220	DIODE(SI)	
D511	PQVDHRU0302A	DIODE(SI)	s
D601	PQVDHRU0302A	DIODE(SI)	s
		(LEDS)	
LED541	PQVDSML310MT	LED	s
LED542	PQVDBR1111C	LED	S
		(COILS)	
L101	PQLQXF330K	COIL	s
L102	PQLQXF330K	COIL	s
L301	PQLQXF100K	COIL	s
L375	PQLQXF100K	COIL	s
L501	PQLQR2KA213	COIL	s
L502	PQLQR4RB601D	COIL	
		(SURGE ABSORBERS)	
SA101	PQVDDSS301L	SURGE ABSORBER	۹ .
	+ · ·		s
SA102	PQVDDSS301L	SURGE ABSORBER	5
		(OTHERS)	-
CN101	PQJJ2H003Z	JACK SOCKET	s
G601	PQJT10152Z	CHARGE TERMINAL	
G602	PQJT10152Z	CHARGE TERMINAL	
G603	PQJT10152Z	CHARGE TERMINAL	
G604	PQJT10152Z	CHARGE TERMINAL	
G605	PQJT10152Z	CHARGE TERMINAL	
G606	PQJT10152Z	CHARGE TERMINAL	
P101	PQRPAR390N	POSISTOR	s
s501	EVQPCQ05K	PUSH SWITCH	
X501	ној409400006	CRYSTAL OSCILLATOR	
		(RESISTORS)	
D102	ED 130EV 1104		
R103	ERJ3GEYJ104	100k	+
R104	ERJ3GEYJ104	100k	
R106	ERJ3GEYJ472	4.7k	
R107	ERJ3GEYJ473	47k	
	ERJ3GEYJ102	1k	_

709LBB			
Ref.	Part No.	Part Name & Description	Remarks
R111	ERJ3GEYJ394	390k	
R112	ERJ3GEYJ394	390k	
R113	ERJ3GEYJ472	4.7k	
R115	ERJ3GEYJ155	1.5M	
R116	ERJ3GEYJ106	10M	
R117	ERJ3GEYJ275	2.7M	
R118	ERJ3GEYJ102	1k	
R120	ERJ3GEYJ103	10k	
R121	ERJ3GEYJ104	100k	
R122	ERJ3GEYJ103	10k	
R124	ERJ3GEYJ472	4.7k	
R132	ERJ3GEYJ393	39k	
R133	ERJ3GEYJ102	1k	
R134	ERJ3GEY0R00	0	
R136	ERDS1TJ330	33	s
R138	ERJ3GEYJ470	47	
R139	ERJ3GEYJ681	680	
R140	ERJ3GEYJ122	1.2k	
R303	ERJ3GEYJ122	1.2k	
R304	ERJ3GEYJ122	1.2k	
R333	ERJ3GEYJ103	10k	
R345	ERJ3GEYJ102	1k	
R371	ERJ3GEYJ331	330	
R372	ERJ3GEYJ561	560	
R373	ERJ3GEYJ390	39	
R374	ERJ3GEYJ560	56	
R375	ERJ3GEYJ470	47	
R376	ERJ3GEYJ470	47	
R377	ERDS1VJ271	270	
R381	ERJ3GEYJ563	56k	
R382	ERJ3GEYJ563	56k	
R383	ERJ3GEYJ103	10k	
R384	ERJ3GEYJ104	100k	
R385	ERJ3GEYJ102	1k	
R411	ERJ3GEYJ394	390k	
R412	ERJ3GEYJ564	560k	
R431	ERJ3GEYJ222	2.2k	
R433	ERJ3GEYJ333	33k	
R434	ERJ3GEYJ102	1k	
R461	ERJ3GEYJ102	1k	
R462	ERJ3GEYJ392	3.9k	
R463	ERJ3GEYJ102	1k	
R464	ERJ3GEYJ394	390k	
R465	ERJ3GEYJ820	82	
R502	ERJ3GEYJ103	10k	
R503	ERJ3GEYJ103	10k	
R504	ERJ3GEYJ103	10k	
R504	ERJ3GEYJ102	1k	
R500	ERJ3GEYJ102	1k	
R507	ERJ3GEYJ102 ERJ3GEYJ103	10k	
R508	ERJ3GEYJ103	10k	+
R511	ERJ3GEYJ103	270k	-
R511	ERJ3GEYJ473	47k	
R512	ERJ3GEYJ181	180	<u> </u>
R541	ERJ3GEYJ561	560	
			+
R601	ERJ3GEYJ123	10h	-
R602	ERJ3GEYJ103	10k	-
R603	ERJ3GEYJ472	4.7k	-
R604	ERJ3GEYJ472	4.7k	
R611	ERJ3GEYJ104	100k	-
R612	ERJ3GEYJ472	4.7k	-
R613	ERJ3GEYJ472	4.7k	-
R615	ERJ3GEYJ102	1k	-
R650	ERJ3GEYJ332	3.3k	_
L100	PQ4R18XJ000	0	s
L511	ERJ3GEY0R00	0	-
l .		(CAPACITORS)	-
G1.00	TOTT 71 01 0 1	0.1	1
C100	ECUV1C104ZFV		1_
C101	ECKD2H681KB	680P	s
C101 C102	ECKD2H681KB ECKD2H681KB	680P	s
C101 C102 C103	ECKD2H681KB ECKD2H681KB PQCUV1H154KR	680P 0.15	
C101 C102	ECKD2H681KB ECKD2H681KB	680P	

Ref. No.	Part No.	Part Name & Description	Remarks
C111	ECKD2H681KB	680P	s
C112	ECKD2H681KB	680P	s
C115	ECUV1H103KBV	0.01	
C121	ECUV1H103KBV	0.01	
C131	ECUV1H101JCV	100P	
C132	ECUV1H103KBV	0.01	
C134	ECEA1HKA010	1	
C139	ECEA1CKA100	10	
C140	ECUV1C473KBV	0.047	
C302	ECUV1C104ZFV	0.1	
C303	ECUV1C104ZFV	0.1	
C304	ECEA1CKA100	10	
C305	ECUV1C104ZFV	0.1	
C306	ECEA1AU471	470	
C308	ECUV1C104ZFV	0.1	
C333	ECUV1C104ZFV	0.1	
C341	ECUV1C104ZFV	0.1	
C371	ECUV1C104ZFV	0.1	
C411	ECUV1H121JCV	120P	
C412	ECUV1A105ZFV	1	
C414	ECEA1CKA100	10	
C415	ECUV1C104ZFV	0.1	
C431	ECUV1H272KBV	0.0027	
C432	ECUV1C104KBV	0.1	
C441	ECUV1C104KBV	0.1	
C445	ECUV1C104KBV	0.1	
C463	ECUV1C104KBV	0.1	
C464	ECUV1H102KBV	0.001	
C467	ECST0JY106	10	
C501	ECEA1AU221	220	s
C502	ECUV1C104ZFV	0.1	
C503	ECUV1C104ZFV	0.1	
C504	ECUV1H681JCV	680P	s
C506	ECUV1H180JCV	18P	
C507	ECUV1H150JCV	15P	
C513	ECEA0JKA101	100	
C514	ECUV1C104ZFV	0.1	
C515	ECST0JY106	10	
C516	ECUV1C104ZFV	0.1	
C551	ECUV1C104ZFV	0.1	
C601	ECEA1AU101	100	s
C602	ECUV1H103KBV	0.01	
C611	ECUV1H103KBV	0.01	
C613	ECUV1C104ZFV	0.1	
C616	ECUV1H330JCV	33P	
C618	ECUV1H030CCV	3P	
C620	ECUV1C104ZFV	0.1	
C681	ECUV1H030CCV	3P	

24.1.3. RF P.C.BOARD PART

Ref. No.	Part No.	Part Name & Description	Remarks
PCB2	POT.P102467	RE BLOCK	

24.2. Handset

24.2.1. CABINET AND ELECTRICAL PARTS

Ref. No.	Part No.	Part Name & Description	Remarks
101	PQAS3P07Y	SPEAKER	
102	PQAX3P27Z	RECEIVER	
103	PQBC10337Z1	NAVIKEY BUTTON	s
104	PQGP10183Z1	LCD LABEL	s
105	PQGT14793Z	NAME LABEL	
106	PQHE10121Z	CUSHION, URETHANE FORM	
107	PQHG10589Y	SP RUBBER SHEET	
108	PQHR10778Z	SP HOLDER	
109	PQHR10855Z	SP HOLDER	
110	PQHR10856Z	LCD HOLDER	

Ref. No.	Part No.	Part Name & Description	Remarks
111	PQHS10457Z	SP NET	
112	PQHS10470Z	CUSHION LCD	
113	PQHX11005Z	LCD SHEET	
114	PQJT10176Z	CHARGE TERMINAL (L)	
115	PQJT10177Z	CHARGE TERMINAL (R)	
116	PQKE10132Z1	EARPHONE CAP	s
117	PQKF10518Z1	REAR CABINET	s
118	PQKK10120Z1	BATTERY COVER	s
119	1DKM10486Z1	FRONT CABINET	s
120	PQPP504SVC	BATTERY	s
121	PQSA10102X	ANTENNA	s
122	PQSX10174Y	KEY RUBBER SWITCH	
123	PQADGP332GN2	LIQUID CRYSTAL DISPLAY	
124	QQQT20007Z	INSERT LABEL, BATTERY	

24.2.2. MAIN P.C. BOARD PARTS

Ref. No.	Part No.	Part Name & Description	Remark
PCB100	PQWPC1703BXR	MAIN P.C.BOARD ASS'Y (RTL)	
TG001	gov:ppg00004	(ICS)	
IC201	C2HBBG000024	IC	
IC202	PQWIC1703BXR	IC	
IC203	C0CBABD00011	IC	
IC204	PQVIC62FP33M	IC	S
IC205	PQVIC61CN32N	IC	s
		(TRANSISTORS)	
Q202	PQVTDTC143E	TRANSISTOR(SI)	s
Q203	PQVTDTA143TU	TRANSISTOR(SI)	
Q205	2SD1819A	TRANSISTOR(SI)	
Q206	PQVTDTC143E	TRANSISTOR(SI)	S
Q207	2SD1819A	TRANSISTOR(SI)	
Q211	PQVTDTA143TU	TRANSISTOR(SI)	
		(DIODES)	
D201	MA2ZD1400	DIODE(SI)	
D203	MA111	DIODE(SI)	
D206	PQVDS1ZB60F1	DIODE(SI)	
D211	MA8100M	DIODE(SI)	
D214	MA111	DIODE(SI)	
D215	MA2ZD1400	DIODE(SI)	
D216	MA111	DIODE(SI)	
		(LEDS)	
LED205	LNJ308G8JRA	LED	
LED206	LNJ308G8JRA	LED	
LED207	LNJ308G8JRA	LED	
		(COILS)	
L201	MQLRE15NJF	COIL	
L203	PQLQR3FL121	COIL	s
L211	PQLQR4RB601D	COIL	
L212	PQLQR4RB601D	COIL	
	TQUQRIRDOOLD	(CONNECTORS)	1
CN201	PQJS22A12Z	FFC CONNECTOR	s
CN201 CN202	PQJP2D13Z	CONNECTOR PIN	s
CN202	PQJJ1J007Z	EAR JACK	s
CNZUS	PQ00100072		P
E101	DO TM1 4737	(OTHERS)	
E101	PQJM147Y	MICROPHONE	
G1	PQJT10152Z	CHARGE TERMINAL	
G2	PQJT10152Z	CHARGE TERMINAL	
G3	PQJT10152Z	CHARGE TERMINAL	
G4	PQJT10152Z	CHARGE TERMINAL	
G5	PQJT10152Z	CHARGE TERMINAL	
G6	PQJT10152Z	CHARGE TERMINAL	
X201	ној409400006	CRYSTAL OSCILLATOR	
	_	(RESISTORS)	
R205	ERJ3GEYJ271	270	
R206	ERJ3GEYJ271	270	
R207	ERJ3GEYJ271	270	
R209	ERJ3GEYJ102	1k	
R210	ERJ3GEYJ103	10k	
R211	ERJ3GEYJ103	10k	
R212	ERJ3GEYJ101	100	
R213	ERJ3GEYJ101	100	
R217	ERJ3GEYF434	430k	s

			KX-TC1
Ref.	Part No.	Part Name & Description	Remarks
No.			
R218	ERJ3GEYF824	820k	s
R222	ERJ3GEYJ101	100	
R224	ERJ3GEYJ103	10k	
R225	ERJ3GEYJ472	4.7k	
R228	ERJ3GEYJ224	220k	
R229	ERJ3GEYJ102	1k	
R230	ERJ3GEYJ102	1k	<u> </u>
R231	ERJ3GEYJ102	1k	
R232	ERJ3GEYJ103	10k	
R233	ERJ3GEY0R00	0	
R234	ERJ3GEYJ225	2.2M	
R235	ERJ3GEYJ225	2.2M	
R236	ERJ3GEYJ473	47k	
R241	ERJ3GEY0R00	0	
R244	ERJ3GEYJ473	47k	
R245	ERJ3GEYJ103	10k	
R246	ERJ3GEYJ153	15k	
R247	ERJ3GEYJ391	390	
R248	ERJ3GEYJ393	39k	
	<u> </u>		
R249	ERJ3GEYJ222	2.2k	-
R250	ERJ3GEYJ222	2.2k	-
R253	ERJ3GEYJ222	2.2k	
R260	ERJ3GEYJ103	10k	
R265	ERJ3GEYJ103	10k	
R270	ERJ3GEYJ104	100k	
R271	ERJ3GEYJ104	100k	
R272	ERJ3GEYJ104	100k	
R300	ERJ3GEYJ104	100k	
R302	ERJ3GEYJ180	18	
R303	ERJ3GEYJ180	18	
C301	ERJ3GEY0R00	0	
L209	PQ4R10XJ000	0	s
		(CAPACITORS)	
C203	ECUV1C104ZFV	0.1	
C205	ECUV1H101JCV	100P	
C206	ECUV1C104KBV	0.1	
C207	ECUV1C104KBV	0.1	
C208	ECUV1C104KBV	0.1	
C209	ECUV1C104KBV	0.1	
C210	ECUV1C104KBV	0.1	<u> </u>
			<u> </u>
C211	ECUV1A474KBV	0.47	
C212	ECUV1A474KBV	0.47	
C213	ECEV0JA101	100	
C214	ECUV1C104ZFV	0.1	
C215	ECUV1A474KBV	0.47	
C217	ECUV1C104ZFV	0.1	
C218	ECUV1C104ZFV	0.1	
C220	ECEV0GA102P	1000	
C221	ECUV1C104ZFV	0.1	†
C222	ECUV1C104ZFV	0.1	
C223		10	+
	ECST0JY106		
C224	ECUV1C104ZFV	0.1	-
C225	ECUV1C104ZFV	0.1	-
C226	ECUV1C104ZFV	0.1	
C227	ECUV1C104ZFV	0.1	
C228	ECUV1C104ZFV	0.1	
C229	ECUV1A105ZFV	1	
C230	ECUV1E333KBV	0.033	
C231	ECUV1A224KBV	0.22	
C232	ECUV1E333KBV	0.033	
C233	ECUV1A105ZFV	1	
C234	ECUV1A224KBV	0.22	
C234	ECUV1H150JCV	15P	
			
C237	ECUV1H150JCV	15P	-
C239	ECUV1C104ZFV	0.1	
C242	ECUV1C104ZFV	0.1	
C255	ECUV1A224KBV	0.22	
C257	ECST0JY226	22	
C262	ECUV1A105ZFV	1	
C267	ECST0JX226	22	1
C270	ECST0JY475	4.7	1
C274			
	ECUV1C104ZFV	0.1	
C277	ECUV1C563KBV	0.056	

Ref.	Part No.	Part Name & Description	Remarks
No.			
C279	ECUV1H010CCV	1P	
C280	ECUV1C104ZFV	0.1	
C282	ECUV1C104ZFV	0.1	
C285	ECUV1C105ZF	1	
C291	ECUV1C104ZFV	0.1	
C294	ECUV1C104ZFV	0.1	
C303	ECST0JY106	10	
C304	ECUV1C104ZFV	0.1	
C305	ECUV1H030CCV	3P	

24.2.3. RF P.C.BOARD PART

Ref. No.	Part No.	Part Name & Description	Remarks
PCB200	PQLP10246Z	RF BLOCK	

24.2.4. ACCESSORIES AND PACKING MATERIALS

Ref. No.	Part No.	Part Name & Description	Remarks
A1	PQLV2LBZ	AC ADAPTOR	\triangle
A2	PQJA10075Z	TEL CORD	
A3	PQKE10130Z1	BELT CLIP	s
A4	PQKL10035Z1	WALL MOUNT ADAPTOR	s
A5	PQQX13147Z	INSTRUCTION BOOK	
A6	PQQW12582Z	BETTERY LEAFLET	
P1	XZB20X35A01	PROTECTION COVER	
		(for Base Unit)	
P2	XZB10X35A02	PROTECTION COVER	
		(for Handset)	
Р3	PQPK13481Z	CARTON BOX	

25 FOR SCHEMATIC DIAGRAM

25.1. Base Unit (27 SCHEMATIC DIAGRAM (Base Unit))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

Components identified by \triangle mark have special characteristics important for safety. When replacing any of these components, use only the manufacturer's specified parts.

2. This schematic diagram and circuit board may be modified at any time with the development of new technology.

25.2. Handset (28 SCHEMATIC DIAGRAM (Handset))

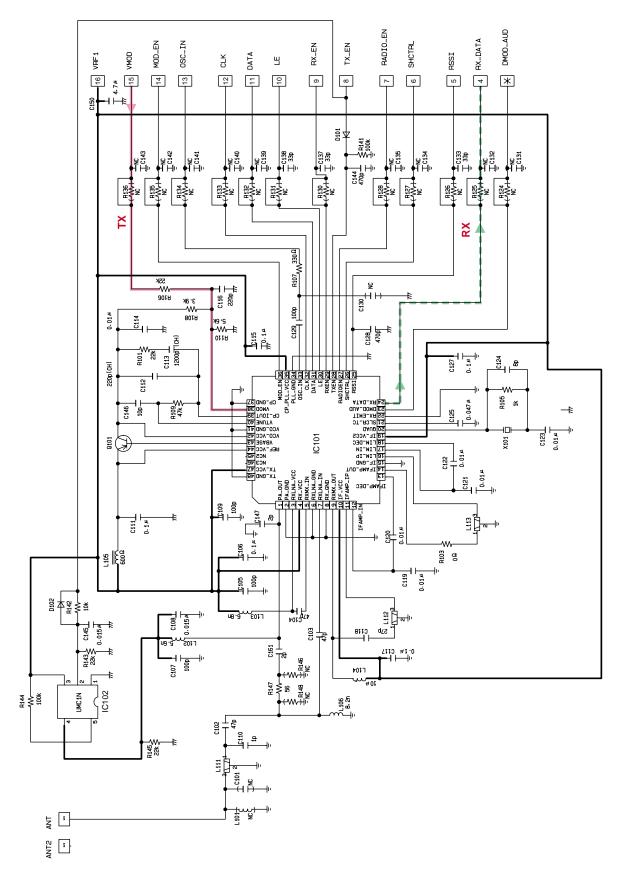
Notes:

- 1. DC voltage measurements are taken with an oscilloscope or a tester with a ground.
- 2. The schematic diagrams and circuit board may be modified at any time with the development of new technology.

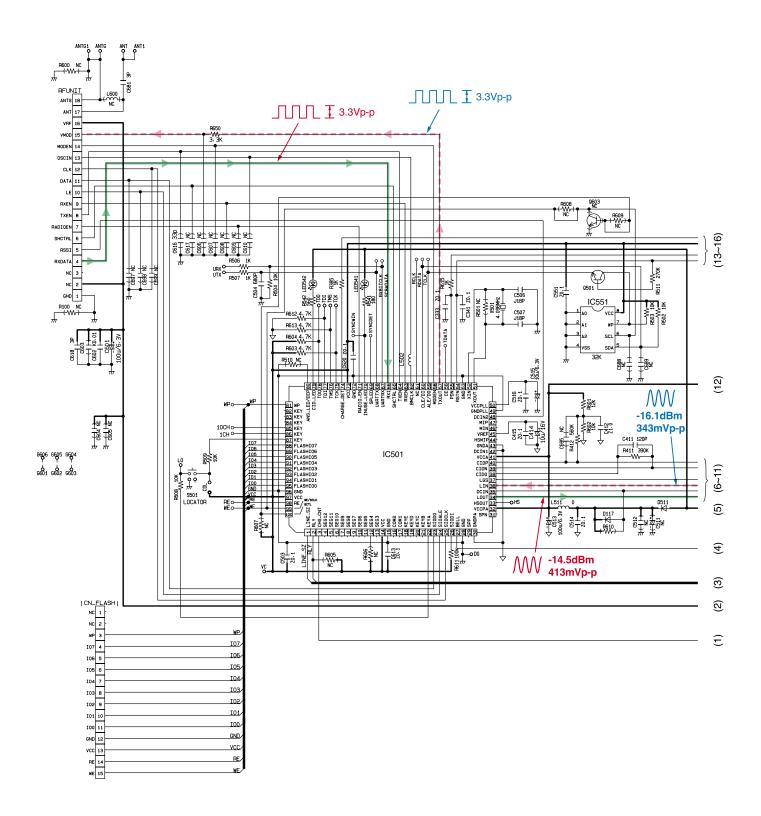
KX-TC1709LBB

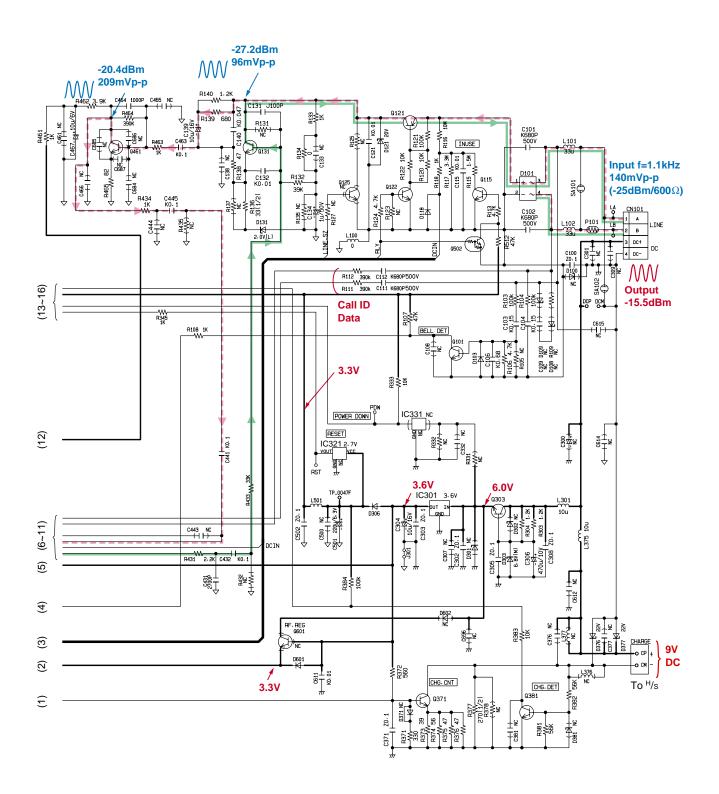
25.3. Memo

26 SCHEMATIC DIAGRAM (RF Unit)



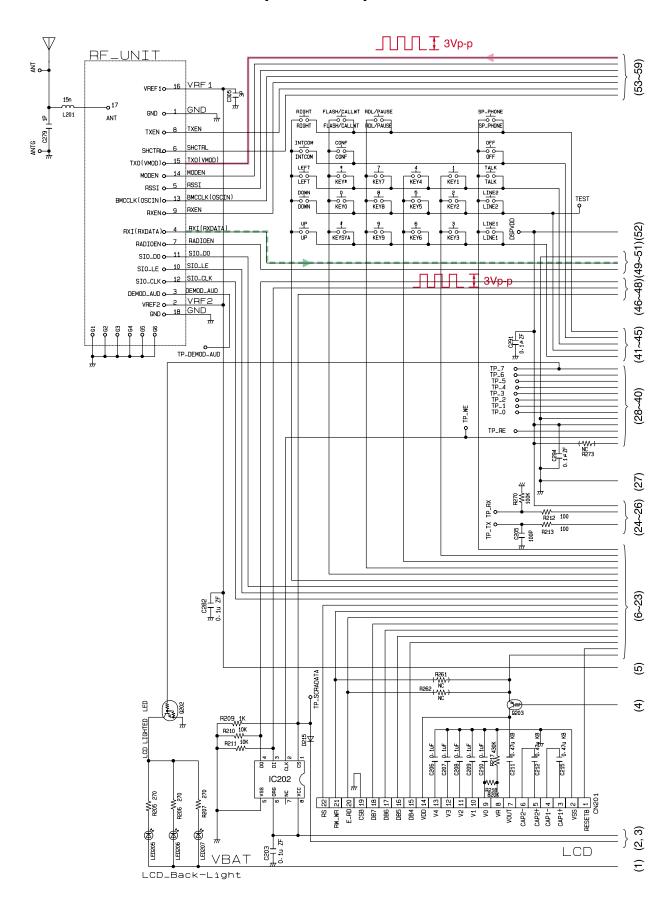
27 SCHEMATIC DIAGRAM (Base Unit)

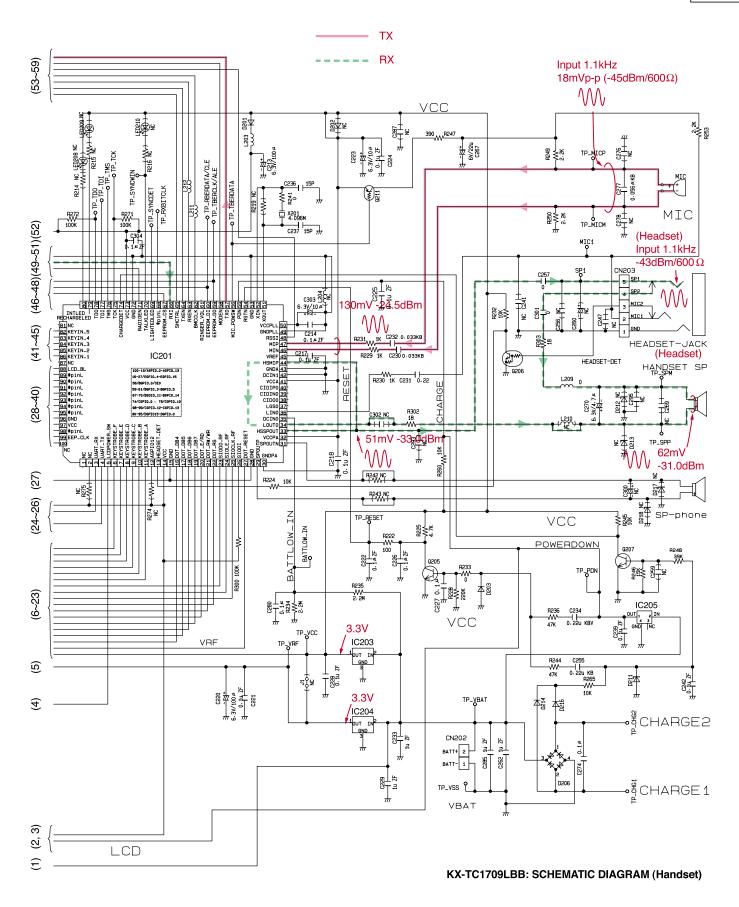




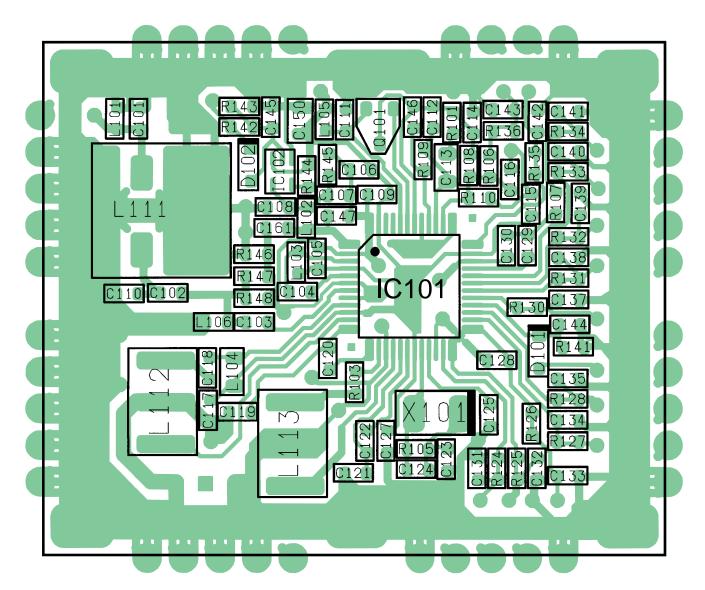
KX-TC1709LBB: SCHEMATIC DIAGRAM (Base Unit)

28 SCHEMATIC DIAGRAM (Handset)



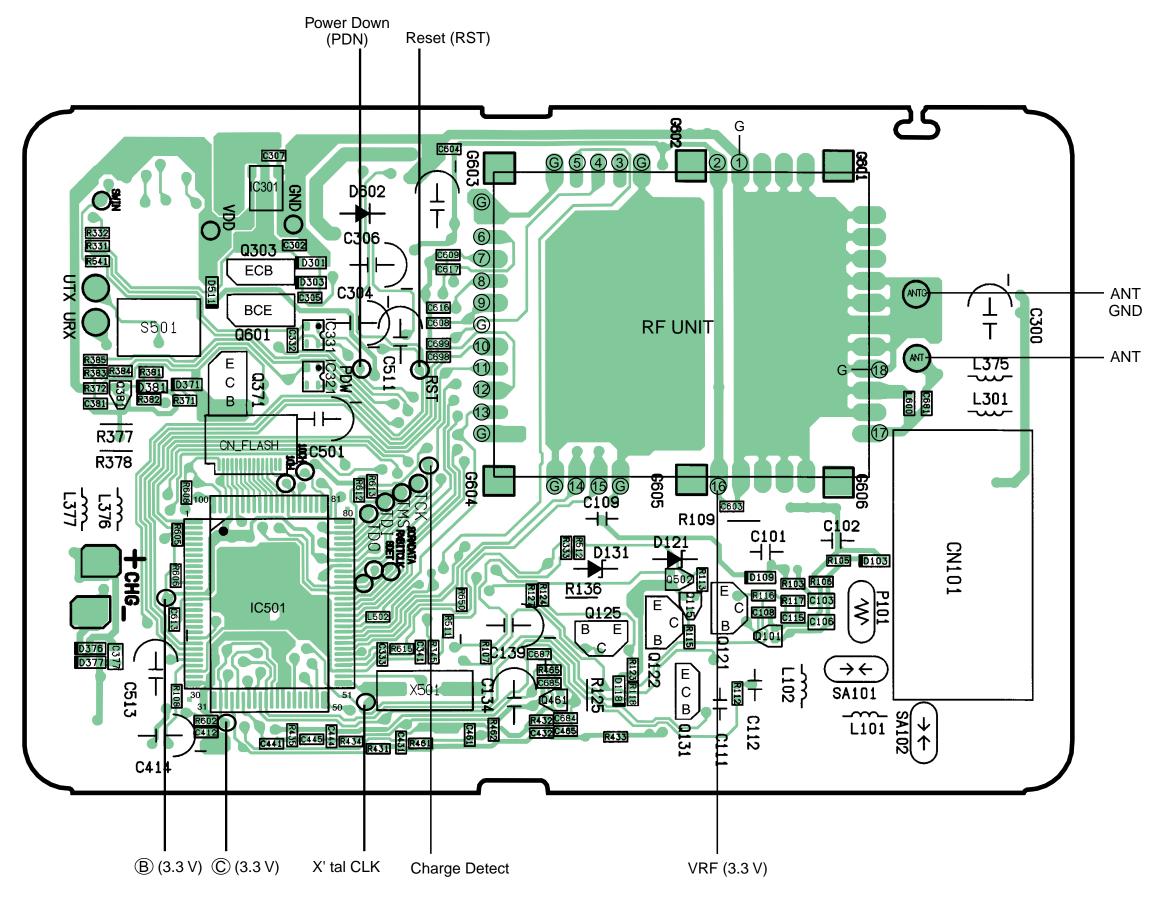


29 CIRCUIT BOARD (RF Unit)

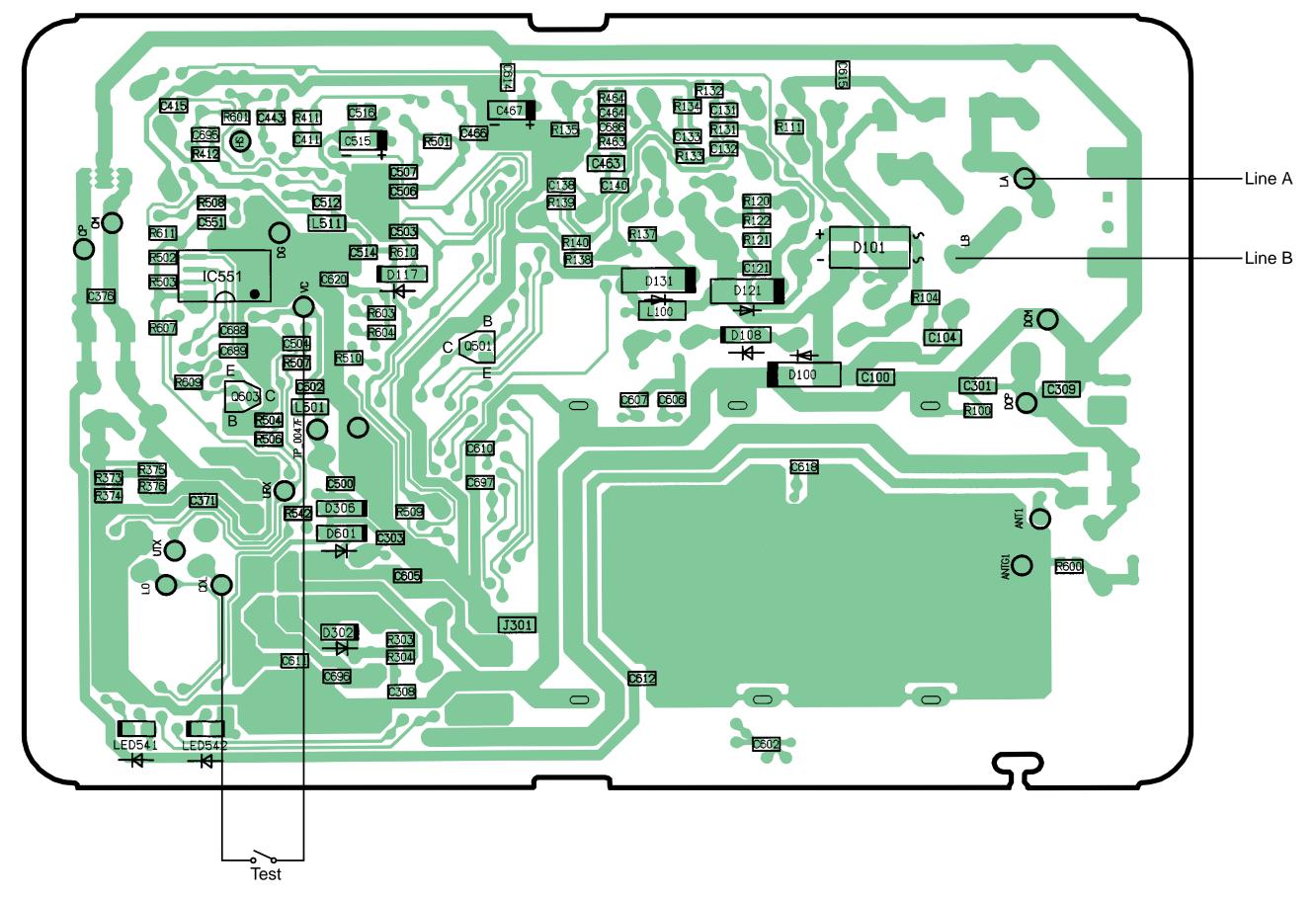


30 CIRCUIT BOARD (Base Unit)

30.1. Component View

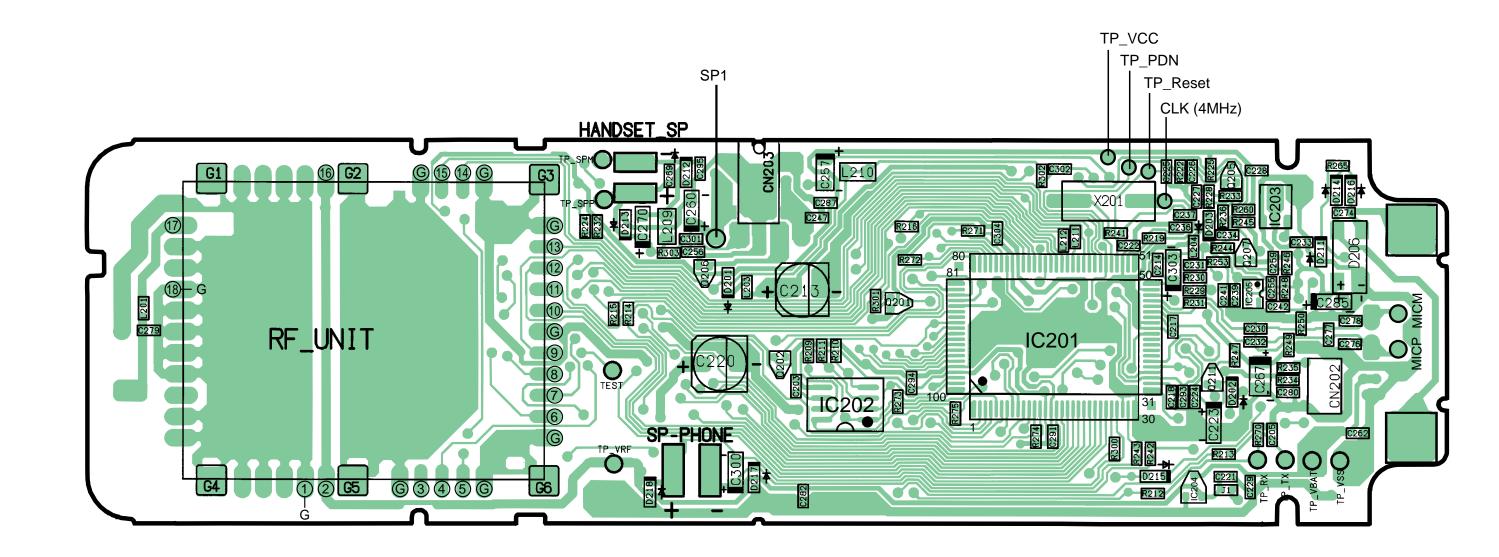


30.2. Flow Solder Side View



31 CIRCUIT BOARD (Handset)

31.1. Component View



31.2. Flow Solder Side View

